Growth dependant properties of undoped and in-situ doped chemically deposited CdS thin films

Aaron John Reynolds
Edith Cowan University

Follow this and additional works at: https://ro.ecu.edu.au/theses_hons

Part of the Semiconductor and Optical Materials Commons

Recommended Citation

This Thesis is posted at Research Online.
https://ro.ecu.edu.au/theses_hons/543
Edith Cowan University

Copyright Warning

You may print or download ONE copy of this document for the purpose of your own research or study.

The University does not authorize you to copy, communicate or otherwise make available electronically to any other person any copyright material contained on this site.

You are reminded of the following:

- Copyright owners are entitled to take legal action against persons who infringe their copyright.

- A reproduction of material that is protected by copyright may be a copyright infringement. Where the reproduction of such material is done without attribution of authorship, with false attribution of authorship or the authorship is treated in a derogatory manner, this may be a breach of the author’s moral rights contained in Part IX of the Copyright Act 1968 (Cth).

- Courts have the power to impose a wide range of civil and criminal sanctions for infringement of copyright, infringement of moral rights and other offences under the Copyright Act 1968 (Cth). Higher penalties may apply, and higher damages may be awarded, for offences and infringements involving the conversion of material into digital or electronic form.
GROWTH DEPENDANT PROPERTIES OF UNDOPED AND IN-SITU DOPED CHEMICALLY DEPOSITED CdS THIN FILMS

Aaron John Reynolds
Student # 0971270

Honours Thesis

Faculty of Communications, Health and Science
Edith Cowan University
Perth Western Australia

Bachelor of Science Honours (Physical Science)
June 2002

Principal Supervisor – Dr Steven Hinckley
USE OF THESIS

The Use of Thesis statement is not included in this version of the thesis.
ABSTRACT

This research project examines the growth dependant properties and composition of Cadmium Sulfide thin films produced by the Chemical Bath Deposition Method. The specific areas investigated are the effect of deposition temperature, the effect of an Indium dopant on the films structure and properties, and the effects of post deposition processing such as annealing in air on the film composition.

The chemical bath deposition apparatus used has been refined and tested to ensure that the films were grown in a more efficient manner than previously, with more control of the influencing deposition parameters such as temperature. Films grown by the CBD method with this apparatus were durable, yellowish in colour, and adherent to the glass substrates used. The CdS thin films were then subjected to a number of analysis techniques to determine their properties. These techniques include Proton Induced X-ray Emission, Atomic Force Microscopy, Secondary Ion Mass Spectroscopy, Environmental Scanning Electron Microscopy with Charge Contrast Imaging, and Photoconductivity.

The results from the analysis of the CdS thin films revealed the presence of nodule structures on the surface of the annealed films. Films produced at lower deposition temperatures seemed to have increased sulfur deficiencies, resulting in an increased Cadmium to sulfur ratio. The Indium doping was found to be inhomogeneous through the depth of the film. The Indium doping concentration in the deposition was also found to be consistent with the concentration found in the films by analysis. Higher deposition temperatures were found to encourage the deposition of colloidal particulates on the surface of the substrates. Annealing of the CdS was found to produce films with surface features that were rougher in appearance.
Declaration

I certify that this thesis does not, to the best of my knowledge and belief:

(I) incorporate without acknowledgement any material previously submitted for a degree or diploma in any institution;

(II) contain any material previously published or written by another person except where due reference is made in the text; or

(III) contain any defamatory material.

Signature

Date
Acknowledgements

I would like to acknowledge the valuable help of the following people without whose assistance this thesis would not have been completed.

Firstly to Dr Steven Hinckley my Honours supervisor, who is very tolerant and has an endless capacity for answering questions and marking thesis revisions.

To the staff at the Western Australian Centre for Microscopy, for their extra friendly assistance with the use of their microscopes, and preparation of excessively large quantities of samples.

To my fellow students that provided endless assistance for all those little questions.

To the Australian Nuclear Science and Technology Organisation and the Australian Institute of Nuclear Science and Engineering for facilitating the PIXE, AFM, and SIMS analysis and their friendly assistance while I visited at their facility.

To the staff in the other schools at Edith Cowan University for their help, their laboratory space and the use of the long list of equipment I borrowed.

Finally to my friends and family who put up with me while I endlessly preoccupied myself with my studies.
Table of Contents

INTRODUCTION .......................................................................................................................... 7
  1-1 PROPERTIES OF CdS ........................................................................................................ 7
  1-2 CHEMICAL BATH DEPOSITION ....................................................................................... 7
  1-3 RESEARCH QUESTIONS .................................................................................................... 8
  1-4 OBJECTIVES ................................................................................................................... 9
  1-5 LIMITATIONS .................................................................................................................. 9
  1-6 SAFETY ........................................................................................................................... 10

REVIEW OF THE LITERATURE ................................................................................................ 11
  2-1 USES AND APPLICATIONS .............................................................................................. 11
  2-2 PROPERTIES NEEDED FOR APPLICATIONS ................................................................. 11
  2-3 CBD GROWTH AND DEPOSITION .................................................................................. 12
  2-4 AS-DEPOSITED CdS PROPERTIES .................................................................................. 15
  2-5 EFFECT OF DOPING ....................................................................................................... 18
  2-6 POST DEPOSITION PROCESSING .................................................................................. 18

THEORY ....................................................................................................................................... 31
  3-1 BAND THEORY OF SOLIDS ............................................................................................ 21
  3-2 PHOTOCO nductivity ......................................................................................................... 26
  3-3 ATOMIC FORCE MICROSCOPY ...................................................................................... 28
    3-3-1 Operation .................................................................................................................. 29
    3-3-2 Contact Mode ........................................................................................................... 29
    3-3-3 Non-Contact Mode .................................................................................................. 30
    3-3-4 Tapping Mode .......................................................................................................... 31
  3-4 PROTON INDUCED X-RAY EMISSION .......................................................................... 32
  3-5 SECONDARY ION MASS SPECTROSCOPY ................................................................... 34
  3-6 ENVIRONMENTAL SCANNING ELECTRON MICROSCOPY ........................................... 35
    3-6-1 Secondary Electron Detector .................................................................................... 36
  3-7 CHARGE CONTRAST IMAGING ....................................................................................... 36

MATERIALS AND METHOD ........................................................................................................ 38
  4-1 CHEMICAL BATH DEPOSITION ....................................................................................... 38
    4-1-1 Background .............................................................................................................. 38
    4-1-2 Current Experimental Apparatus ............................................................................. 39
    4-1-3 Experimental Technique ......................................................................................... 40
    4-1-4 Post Deposition Processing ..................................................................................... 41
  4-2 SECONDARY ION MASS SPECTROSCOPY .................................................................... 42
    4-2-1 Sample Preparation ................................................................................................. 42
    4-2-2 Analysis .................................................................................................................... 42
    4-2-3 Charge Compensation ............................................................................................ 43
  4-3 ATOMIC FORCE MICROSCOPY ...................................................................................... 43
    4-3-1 Analysis .................................................................................................................... 43
    4-4 CHARGE CONTRAST IMAGING .................................................................................... 44
    4-4-1 Sample Preparation ................................................................................................. 44
    4-4-2 Analysis .................................................................................................................... 44
  4-5 PROTON INDUCED X-RAY EMISSION .......................................................................... 44
    4-5-1 Analysis .................................................................................................................... 44
  4-6 ELECTRICAL MEASUREMENTS ..................................................................................... 45
    4-6-1 Analysis .................................................................................................................... 45

RESULTS ................................................................................................................................... 47
  5-1 CHEMICAL BATH DEPOSITION ....................................................................................... 47
  5-2 VISUAL ANALYSIS .......................................................................................................... 48
  5-3 SECONDARY ION MASS SPECTROSCOPY .................................................................... 50
  5-4 ESEM CHARGE CONTRAST IMAGING ........................................................................... 58
  5-5 ATOMIC FORCE MICROSCOPY .................................................................................... 66
INTRODUCTION

The primary purpose of this project is to examine the growth dependant properties of Cadmium Sulfide (CdS) deposited by the Chemical Bath Deposition (CBD) method in the form of a thin film. Through this undertaking, it is hoped to gain an understanding of the defect structure, the effect of in-situ doping and post deposition processing on these Cadmium Sulfide thin films.

1-1 Properties of CdS
CdS is a II-VI semiconductor, meaning its constituents come from the second and sixth periods of the periodic table. CdS as a semiconductor has a large band gap between its valance band and conduction band, approximately 2.4 eV. This means that at room temperature it is almost an insulator. Thin film CdS is an intrinsic slightly n-type semiconductor, due to a sulfur deficiency in the films (Mahanty et al., 1999). Typically, CdS is doped with elements such a Indium to promote it's n-type semiconducting nature. This has the effect of decreasing the band gap and providing more charge carriers for the conduction of current. CdS appears as a yellowish coloured crystalline substance, and for the purpose of this project is in the form of a thin film deposited on a slide. This unique substance also has the added benefit of being transparent and very durable.

1-2 Chemical Bath Deposition
The technique used to deposit the CdS on a substrate in this study will be the Chemical Bath Deposition method. This process is cheap, simple and operates at a relatively low temperature between 60 and 80°C. Several processing effects will be examined to gain a greater understanding of how they impact on the optoelectronic properties. These processes include in-situ doping and post-deposition annealing. Doping concentration will be examined as will the effect of annealing at a temperature of 400°C.
**1-3 Research Questions**

CdS is a very versatile substance in that its properties can be tailored to some degree by altering the conditions under which it is produced. To understand how these production conditions influence the properties of CdS a few questions need to be answered.

Firstly, what is the effect of in-situ doping on the CdS thin films? When considering the effects of in-situ doping the specific properties being examined are surface morphology and the optoelectronic properties.

What are the effects of in-situ doping on the morphology and defect structure of the films surface?

What are the effects of in-situ doping on the optoelectronic properties of the CdS thin films, specifically the dark conductivity and the photosensitivity?

Also, does the in-situ doping incorporate the Indium into the lattice structure of the CdS?

What is the effect of changing the temperature at which the CdS thin films are deposited onto the substrates?

What is the effect of post deposition processing on the CdS thin films? This can be further broken down.

What is the effect of annealing the CdS thin films at high temperatures as opposed to leaving them as-deposited?

Finally what effect does the atmosphere have on the CdS thin films during the annealing process?
1.4 **Objectives**

The main objective of this study is to gain a greater understanding into the properties of CdS thin films that are influenced by the aspects of its growth and post deposition processing. This objective is achieved by defining a number of aims:

- Design and refine the CBD apparatus used to grow the CdS thin films for the purpose of increasing efficiency and stability of the CBD system.

- Grow a range of CdS thin films with varying Indium dopant levels at a range of different deposition temperatures.

- To anneal a full set of the created films and compare their properties with the as-deposited films.

- To conduct a series of optoelectrical measurements to determine photosensitivity and dark conductivity of the CdS films, and the effects Indium doping and annealing may have.

- Analyse as-deposited and annealed CdS films with a range of surface analysis techniques such as SIMS, ESEM, CCI, and PIXE, and gain an understanding of these analysis tools, along with the type of information they can give.

1.5 **Limitations**

Several limiting factors were encountered while conducting this study. The SIMS and PIXE analysis conducted on the CdS thin films made possible by a grant supplied by AINSE for work at ANSTO was to be completed within 5 days. Time on both the SIMS and PIXE was extremely limited and there was no availability for extra time, which meant that only a small number of samples could be examined.

Unfortunately, during the time that the PIXE measurements were to be conducted the 3MV accelerator was unavailable due to extensive technical difficulties and maintenance issues. The samples that were to be analysed with PIXE had to be left behind and analysed by staff at the ANSTO facility at a later date. This placed considerable restrictions on the ability to gain any experience using the PIXE
equipment. Only a qualitative analysis of the SIMS samples could be conducted as no standard sample of CdS was available for quantitative Analysis.

1-6 Safety
Due to the dangerous nature of the chemicals being handled and Edith Cowan University's policy on Occupational Safety and Health, several steps were taken to ensure safety while experimenting with CdS and its related chemicals. Firstly, Material Safety Data Sheets (MSDS) were obtained for all the relevant chemicals, so that possible risks that exist in dealing with these substances could be identified. A copy of the relevant MSDS can be found in Appendix A. The following measures were taken in accordance with the information obtained from the MSDS.

All experimentation with chemicals was conducted in a fume cupboard. Personal protective equipment was worn, including a laboratory coat, safety goggles, and latex gloves. All glassware equipment was cleaned after each use. When produced, all samples were stored in resealable plastic containers and handled with gloves and tweezers.
REVIEW OF THE LITERATURE

2-1 Uses and applications
CdS has a multitude of uses and applications in several important areas of study. This is due to an increasing interest that has been received by CdS as a wide energy band gap semiconductor. As a result a range of applications has been developed such as terrestrial photovoltaic solar cells, piezoelectric transducers, imaging displays, and material used in the construction of lasers (Vazquez-Luna, 1998).

Heterojunction solar cells that consist of numerous types of narrow band gap semiconductors such as CuInSe₂, CuInS₂, InP, Cu₂S require a window layer. Here CdS's use as a direct band gap II-VI semiconductor is being exploited. By controlling the composition of the CdS thin film, the band gap can be influenced in order to be more responsive to different solar spectra that are absorbed in the window layer (Mahanty et al., 1999). CdS thin films of are also being found suitable for applications in imaging and visual displays in the form of Thin Film Transistors (TFT). Here thin films of CdS can be used to produce circuits on large area, low temperature substrates (Gan & Shi, 2002). CdS has also been found useful in such applications as photoconductive detectors (e.g. Light Dependant Resistors), and as a possible passivation layer in HgCdTe photodetectors.

2-2 Properties needed for applications
There is currently a wide variety of applications that CdS films can be utilised in. This is attributed to the far reaching properties of the films, and the ability to tailor the properties of the CdS by manipulating the production conditions.

CdS has been recently recognised as a good candidate in the active layer of Thin Film Transistors (TFT) used in electronic displays and imaging applications (Gan & Shih, 2002). For CdS to be useful in this area a number of specific properties are required. The CdS TFT will require a relatively large on/off current ratio. The hall mobility \( \mu_H \) and field effect mobility \( \mu_{FE} \) have to be in the region of that of amorphous Silicon. When the TFT is in the off state, the leakage current between the drain and source
should be quite small, less than 10pA. Also the current in the on state at a given voltage should be relatively large, greater than 1μA. The TFT's threshold voltage \( V_T \) must be small \( (V_T = 2.5V) \), and a large mobility is required of the charge carriers in the channel \( (\mu_{FE} = 0.2-1.0 \text{ cm}^2\text{V}^{-1}\text{s}^{-1}) \).

For a number of years now CdS has been considered and is being developed as a window layer in solar cells for terrestrial use. Typically the solar cell is constructed as a heterojunction composed of CdTe, CdS, and a transparent conducting oxide (TCO). In this type of junction, the CdTe is used as the solar cell absorber layer. The TCO provides a highly transparent (>90%) conductive coating making electrical contact to the CdS. For the CdS layer to be useful in this area, it must satisfy several requirements. Firstly, the CdS film should be conductive, and it should have charge carriers in the vicinity of \( n \approx 10^{16} \text{ cm}^{-3} \). This is to ensure that the cell resistance is kept to a minimum. Secondly, the CdS film should be quite thin to allow for a high transmission of light through to the CdTe layer, as charge carriers generated in the CdS layer are generally lost. However, the primary concern for the CdS layer is that it prevents surface recombination loss in the CdTe layer. Typically acceptable values for film thickness are between 50 and 100 nm. Lastly, the films have to be uniform over the cell; if this requirement is not satisfied short circuit effects will occur (Durose et al., 1999).

CdS thin films are also well suited in applications such as photodetectors and other photoconductive devices. There are two key properties that a good photodetector should possess. The first is a low dark conductivity. When the detector is in the absence of any light, the device should have a relatively low conductivity. The other property the device should have is a good photosensitivity. When the photodetector is in the presence of light, the resistance of the device should change dramatically. The ideal photoconductor has a large difference in conductivity between the off state when there is no light and the on state when there is light.

2-3 CBD growth and deposition
There are many methods available for producing CdS thin films. Some of these include Molecular Beam Epitaxy, Thermal Evaporation, Sputtering, Chemical Vapor Deposition, Electrodeposition, Spay Pyrolysis and Chemical Bath Deposition (Mahanty
et al., 1999). Of these processes, the CBD method is the simplest and relatively cheapest method available, as the equipment required is readily available in most chemistry laboratories and the chemicals used are quite inexpensive. The method is particularly suited to large scale depositions, as it can form consistent films that are smooth, hard, and pinhole free. Additionally, this method can produce near stoichiometric CdS due to growth kinetics inherent in the method (Al Kuhaimi & Tulbah, 2000).

The CBD of CdS revolves around the combination of cadmium and sulfide ions in solution. There are three major chemicals involved in this reaction. Thiourea CS(NH$_2$)$_2$ provides the sulfide ions for the deposition process. Cadmium Acetate Cd(CH$_3$COO)$_2$ provides the Cadmium ions to be deposited, and Ammonia NH$_3$ affects the pH of the CBD system and effectively controls the ion by ion deposition rate. The complete reaction of the CBD system is:

$$\text{Cd(NH}_3)_2^+ + \text{CS(NH}_2)_2 + 2\text{OH}^- \Rightarrow \text{CdS} + \text{CH}_2\text{N}_2 + \text{NH}_3 + 2\text{H}_2\text{O} \ [2-3-1]$$

This formula gives a general idea of reagents used and products produced. However, it does not show how each reagent interacts with the system in the chemical bath. To examine the purpose of each reagent Equation 2-3-1 needs to be broken up. Equation 2-3-2 shows the formation of Cadmium Hydroxide from Cadmium ions and Hydroxide ions present from dissolved Cadmium and Ammonia, respectively.

$$\text{Cd}^{+2} + 2\text{OH}^- \Leftrightarrow \text{Cd(OH)}_2 \ [2-3-2]$$

Sulfide ions are formed through the hydrolysis of Thiourea and hydroxide ions:

$$\text{CS(NH}_2)_2 + 2\text{OH}^- \Rightarrow \text{S}^{2-} + \text{CH}_2\text{N}_2 + 2\text{H}_2\text{O} \ [2-3-3]$$

The controlled release of Cadmium ions can then be facilitated by the decomplexing of Cadmium:

$$\text{Cd(NH}_3)_2^{+2} \Leftrightarrow \text{Cd}^{+2} + 4\text{NH}_3 \ [2-3-4]$$
Cadmium Hydroxide then participates in an exchange of Sulfide ions for Hydroxide ions:

\[
\text{Cd(OH)}_2 + \text{S}^{2-} \rightleftharpoons \text{CdS} + 2\text{OH}^-
\] [2-3-5]

The Cadmium and Sulfide ions then combine to form CdS:

\[
\text{Cd}^{+2} + \text{S}^{2-} \Rightarrow \text{CdS}
\] [2-3-6]

The Ammonia dissolves in the CBD system and complexes with the free Cadmium ions as follows:

\[
\text{NH}_3 + \text{H}_2\text{O} \rightleftharpoons \text{NH}_4^+ + \text{OH}^-
\] [2-3-7]

\[
\text{Cd}^{+2} + n\text{NH}_3 \rightleftharpoons \text{Cd(NH}_3)_n^{+2}
\] [2-3-8]

\[
\text{Cd(OH)}_2 + 4(\text{NH}_3) \rightleftharpoons \text{Cd(NH}_3)_4^{+2} + 2\text{OH}^-
\] [2-3-9]

While the solubility product remains dominate in regards to the ionic product of CdS, an ion by ion deposition system will be the predominant deposition process. When the solubility product is exceeded by the ionic product, the formation of particulates in the solution and on the substrates will be predominant (Gluszak, 1996). Figure 2-3-10 shows a graph of the pH of the system vs Cadmium ion concentration. Two lines are shown, the hydroxide and complex lines for Cadmium. The shaded area in region I between the hydroxide line and the complex line, along with the shaded area just above the hydroxide line in region II, show conditions which are optimal for producing thin films via the ion by ion deposition system (Duncan, 2001). With this model the deposition conditions can be controlled to produce a chemical reaction inside the shaded regions.
2-4 As-deposited CBD CdS Properties

Various production aspects such as deposition conditions, doping, and post deposition processing influence the properties of CdS films. The deposition of the films is one of the more significant aspects, as it affects the composition of the CdS films directly. The temperature used in depositing the films, the concentration of the reagents, the length of time used to deposit the CdS, and the pH of the CBD system all contribute to the result of the deposition.

There exists a large quantity of information concerning CdS films produced by the CBD method. A firm grounding in the optoelectrical properties of these films does not yet exist, as evidenced by the disagreement of data reported by different authorities. This can be accounted for when one considers the relationship between the optoelectrical properties, the film microstructure and how the post deposition processing and deposition conditions interact. For example, the dopant level, film microstructure and film thickness act directly to vary the films electrical resistivity by several orders of magnitude. The temperature the films are deposited at, and the composition of the chemical bath solution, can influence the optical absorption coefficient. The energy
band gap can be reduced via annealing in different gases (Rakhshani & Al-Azab, 2000). Where appropriate quantities of reactants are available, films can be made to exhibit increased on-currents and field effect mobilities by depositing them at raised temperatures and pH values (Gan & Shih, 2002). By increasing the Cadmium to Sulfur ratio the band gap ($E_g$) can be decreased, this relationship being very close to linear. When the film is near stoichiometric the band gap is in the region of 2.43 eV (Mahanty et al., 1999). Figure 2-4-1 shows the relationship between Cadmium-Sulfur ratio and the band gap.

![Figure 2-4-1 Relationship between Cd/S ratio and the energy band gap (Adapted from Mahanty et al., 1999).](image)

Table 2-4-2 gives a brief summary of the studies done by other researchers on the CBD method and their main points.
Table 2-4-2 Summary of previous studies.

<table>
<thead>
<tr>
<th>Deposition Type</th>
<th>Study Description</th>
<th>Comments</th>
<th>Reference</th>
</tr>
</thead>
<tbody>
<tr>
<td>CdS CBD</td>
<td>Growth modes of Solution grown CdS thin films</td>
<td>Formation of CdS films in CBD is brought about by two growth modes, ion by ion condensation and colloidal particles of CdS adhering to substrate surfaces. Bath composition affects the film growth modes.</td>
<td>Sebastian et al., 1995</td>
</tr>
<tr>
<td>CdS CBD</td>
<td>Cadmium sulfide thin films prepared by chemical bath deposition method.</td>
<td>The deposition rate of films is increased by conditions of higher temperature and/or higher pH values. There is a weak increasing tendency in the film thickness with the increase of the pH value.</td>
<td>Kuranouchi et al., 1994</td>
</tr>
<tr>
<td>CdTe/CdS junction CdS CBD</td>
<td>Materials aspects of CdTe/CdS solar cells.</td>
<td>Studies show a 10-20% excess of Cd over S which can be attributed to the presence of Cd(OH)$_2$ and CdO. Heating in air eliminates water from Cd(OH)$_2$ to give CdO.</td>
<td>Durose et al., 1999</td>
</tr>
<tr>
<td>CdS CBD</td>
<td>Optical and electrical characterization of CdS films.</td>
<td>CdS films annealed in CdCl$_2$ flux for 10 minutes at 400°C exhibit a much larger grain size than as-deposited films.</td>
<td>Ozan et al., 1996</td>
</tr>
<tr>
<td>CdS CBD</td>
<td>Microstructural effects of thermal annealing on CdS films.</td>
<td>One effect of thermal annealing on CdS films deposited by CBD is the occurrence of a band gap shift. Thermally treated samples show an optical gap lower than the band gap.</td>
<td>Galvan et al., 1996</td>
</tr>
</tbody>
</table>

Electrical measurements carried out at room temperature on as-deposited CdS films indicate that they are highly resistive, greater than $10^6$ s. Composition measurements using Energy Dispersive Analysis of X-rays (EDAX), indicate that the as-deposited
films have a Cadmium to Sulfur ratio greater than one and are therefore deficient in Sulfur (Mahanty et al., 1999).

2-5 Effect of Doping
Doping is another important aspect in the production of CdS, particularly in areas where electrical conductivity is concerned. The type of dopant used and its concentration in the CdS film has a significant effect on the electrical properties. When considering dopant quantities, the molar concentration of the dopant should be below that of Cadmium and Sulfur in the deposition system.

When semiconductors such as CdS are doped with other materials such as Indium, the optical characteristics change due to the formation of impurity energy levels within the band gap. One of these impurity energy levels corresponds to a donor level approximately 0.1 eV below the conduction band, due to sulfur vacancies. Cadmium vacancies will produce an acceptor level 1.1 eV above the valence band. Indium will also produce an acceptor level above the valence band due to Indium vacancies (Sebastian, 1995).

Photosensitivity of CdS will increase when doped with an impurity such as Indium. Increasing the concentration of the dopant will have the effect of increasing the photosensitivity further still. This is due to the increase in vacancies present with the dopant, the dopant vacancies together with the Cadmium and Sulfur vacancies produce photosensitisation centers in the CdS thin film (Sebastian, 1995).

2-6 Post deposition processing
Post deposition processing covers the annealing of the CdS films at different temperatures anywhere between 150 and 400°C and has a marked impact on the structural and electrical properties. Specifically, the crystallinity and electron mobility can be manipulated. The duration of the annealing process and the type of gas atmosphere or vacuum used are also important components of the annealing process.

As-deposited CdS films have been found to have relatively low electron mobilities. By annealing them the quality of the crystal structure can be improved, which increases the
mobility of electrons (Gan & Shih, 2002). Stoichiometric CdS films that are annealed in air have an excess of Cadmium present, whereas the same film annealed in a vacuum has been found to be in excess of Sulfur (Mahanty et al., 1999). Annealing in an air atmosphere also has the effect of increasing the donor density very slightly above that of the as-deposited CdS thin films. Annealing in a CdCl₂ atmosphere has the effect of increasing the donor density level by approximately three times (Ozan et al., 1996).

Annealing decreases the band gap energy markedly. This is due to the conversion of some of the CdS to other compounds. Annealing in air introduces Oxygen and water vapour into the system, which will be absorbed and then diffuse into the film’s lattice interacting with the other components (Gluszak & Hinckley, 1999).

The effect of the annealing temperature on the films is very important as it will determine the potential usefulness of the substance. One of the properties affected by annealing is the photosensitivity defined as:

\[ S = \frac{I_{\text{ph}} - I_{\text{dark}}}{I_{\text{dark}}} \]  

Where \( I_{\text{ph}} \) is the current in the semiconductor where illumination is present, and \( I_{\text{dark}} \) is the current in the dark. Unannealed films are highly resistive in the dark, with a dark resistance of \( 0.25 \times 10^3 \Omega \cdot \text{cm} \), and a photosensitivity of approximately \( 10^3 \) (Gluszak & Hinckley). CdS thin films annealed up to a temperature of \( 150^\circ \text{C} \) have a markedly increased photosensitivity of \( 10^6 \). Annealing the CdS thin films at \( 200^\circ \text{C} \) decreases the photosensitivity to approximately \( 10^4 \), and annealing at temperatures above this further decreases the photosensitivity, however, this is due to an increase in the dark current by approximately \( 10^4 \). Annealing at temperatures up to \( 400^\circ \text{C} \) will lead to a large decrease in the Sulfur. The loss of the Sulfur takes place through the reaction (Gluszak & Hinckley, 1999):

\[ 2\text{CdS} + 3\text{O}_2 \rightarrow 2\text{CdO} + 2\text{SO}_2 \]
Due to the loss of Sulfur, additional vacancies are created which work to improve the dark conductivity. The increased dark carrier concentration in the CdS thin film leads to a decreased photosensitivity according to equation 2-6-2. (Sebastian, P. J. 1995).
THEORY

There is a large quantity of literature concerning the theory of semiconductors. In this section, priority is given to the material directly relating to the optoelectronic, structural properties and composition being examined. These include the band theory of solids, photoconductivity, atomic force microscopy, proton induced x-ray emission, secondary ion mass spectroscopy, and charge contrast imaging.

3-1 Band Theory of Solids

The band theory of solids explains the process by which charge carriers are generated, move through a solid, the electron conduction process, and optical properties. All solids are grouped together into three main categories, conductors, insulators and semiconductors. The operation of conductors and insulators is fairly elementary and not really relevant. However, semiconductors behave in a more interesting manner and have a direct relationship to the optoelectronic properties being examined.

When atoms are brought close together, their wave functions overlap, splitting the possible energy levels that are available. When there are a large number of atoms brought together such as in a solid, the energy levels split into almost continuous bands. This is illustrated in Figure 3-1-1.

![Figure 3-1-1 Splitting of energy levels to form energy bands (adapted from Streetman & Banerjee, 2000).]
Band theory describes a semiconductor as having two bands, a valence band and a conduction band separated by a band gap. The valence band is defined as the highest occupied band at absolute zero, and contains the valence electrons. The conduction band is the next band up, higher in energy and is generally empty at absolute zero. These two bands are separated by the energy band gap, which is a forbidden zone where electron states due to the host lattice do not exist. This is shown in Figure 3-1-2.

![Energy level diagram of a semiconductor](image)

Figure 3-1-2 Energy level diagram of a semiconductor (adapted from Streetman & Banerjee, 2000).

In its lowest energy state, a semiconductor has no available charge carriers, meaning the valance band is filled and the conduction band is empty. This means the semiconductor can conduct no current hence, at absolute zero, all semiconductors are insulators. However, when electrons become excited by an appropriate amount of energy, they can jump the band gap from the valence band to the conduction band thus generating an electron hole pair. The band gap or forbidden energy band is shown in Figure 3-1-2 as $E_g$. Holes can be considered a vacant electron state in the valence band that move in the opposite direction to electrons. Electron energy increases upwards through the valence and conduction bands, whereas hole energy increases downwards through the conduction and valence bands. Electrons and holes in a crystal lattice can not be considered to be completely free, as they interact with the periodic potential of the lattice. This can be accounted for by changing the actual mass of the charge carrier to an effective mass as shown by:
Where $m^*_e$ is the effective mass of an electron (kg), $h$ is Planck's constant (J·s), $E$ is the energy (J), and $k$ is the wave vector (cm$^{-1}$).

A semiconductor is said to be intrinsic when its lattice structure is perfect. Extrinsic semiconductors on the other hand are created when doped to change the intrinsic equilibrium carrier concentration of electrons and holes. Doping is used to create charge carriers in a semiconductor by introducing impurities into the crystal lattice. It is used to vary the conductivity of the semiconductor. Doping alters a semiconductor so that it has a predominance of electrons or holes. This produces two types of semiconductors, $n$-type that have mostly electrons as charge carriers, and $p$-type that have mostly holes as charge carriers. When impurities or defects are introduced into the crystal structure, energy levels are created in the band structure, usually within the forbidden gap. This is shown in Figure 3-1-4.

Energy levels that are created near the conduction band donate electrons to the conduction band, and these levels are thus referred to as donor levels. At absolute zero,
these donor levels are full of electrons. Very little energy is generally required to promote electrons from the donor level to the conduction band, which increases the materials conductivity at lower temperatures. This produces semiconductors with large numbers of electrons in the conduction band and are generally referred to as n-type semiconductors. Impurity energy levels created near the valence band accept electrons from the valence band, and for this reason are called acceptor impurity levels. At absolute zero, these energy levels are devoid of electrons, and very little energy is required to excite electrons from the valence band to this impurity level, thus also increasing the conductivity of the semiconductor at lower temperatures by creating holes in the valence band. Doping of this type creates materials with much greater hole concentrations in the valence band than electrons in the conduction band, and are termed p-type semiconductors. The electron and hole concentrations can be represented by:

\[
\begin{align*}
n_0 &= n_i e^{(E_i - E_f)/kT} \tag{3-1-5} \\
p_0 &= n_i e^{(E_f - E_i)/kT} \tag{3-1-6}
\end{align*}
\]

Where \( n_i \) is the intrinsic electron concentration (cm\(^{-3}\)), \( E_i \) is the intrinsic Fermi level (J, eV), \( E_f \) is the equilibrium Fermi level (J, eV), \( k \) is Boltzmann's constant (J/K, eV/K), and \( T \) is the temperature (K). It should be noted that \( n_i \) is the carrier concentration due only to the temperature of the semiconductor, in the absence of doping and impurities.

This electron-hole pair generation process also occurs in the reverse direction and is called carrier recombination. In recombination, the electron loses energy and falls back down to the valence band, combining with a hole. In between these two processes the two charge carriers are free to conduct current across the semiconductor. The recombination of electron hole pairs can proceed in two ways, direct and indirect recombination, shown in Figure 3-1-7.
In direct recombination, the electron-hole pairs decay by electrons moving from the conduction band down to the valence band and annihilating with a hole, the energy lost is given up as a photon. The time between when charge carriers are generated and recombine is termed the carrier lifetime, and in direct recombination is given by:

$$\tau_n = \frac{1}{\alpha_r (n_0 + p_0)} \quad [3-1-8]$$

Where $\tau_n$ is the recombination lifetime of electrons(s), $\alpha_r$ is the recombination coefficient (cm$^3$/s), $n_0$ is the equilibrium electron concentration (cm$^{-3}$), and $p_0$ is the equilibrium hole concentration (cm$^{-3}$).

Indirect recombination occurs via recombination impurity levels or traps present within the energy band gap. The energy lost through these recombinations is less than that given up in direct recombination, and is passed to the lattice as heat. Recombination levels are the result of impurities and lattice defects, that are able to capture both types of charge carriers thus annihilating an electron hole pair. The carrier lifetime for indirect recombination is far more complex than that for direct recombination. The recombination time is dependant on the time for two opposite charges to be captured. If the recombination site does not capture the second charge carrier immediately after the
first, then it may be thermally re-excited. This means the first charge carrier must then be recaptured. Recombination by way of trap levels deeper in the energy band gap take longer as more energy is required than levels closer to the band edges. The distribution of electrons in the many energy levels as a function of $E$ and $T$ is determined by the Fermi-Dirac distribution:

$$F_{FD} = \frac{1}{1 + \exp\left(\frac{E}{kT}\right)}$$  \[3-1-9\]

Where $B_1$ is a normalisation constant, $E$ is the energy (J,eV), $k$ is Boltzmann’s constant (J/K, eV/K), and $T$ is the temperature in Kelvin. At absolute zero all the atoms in the solid are in the ground state. When the temperature is increased, more atoms are expected to be in excited states and thus the probability of finding an electron that has jumped the energy gap into the conduction band is higher. Therefore, the higher the temperature, the more electrons are expected to be promoted from the valence band to the conduction band. This causes the resistance of the semiconductor to decrease. The general relationship is that resistance in semiconductors decreases exponentially with increasing temperature (Thornton & Rex, 1993).

### 3-2 Photoconductivity

Photoconductivity is very similar to the photoelectric effect in that photonic radiation energises electrons making them more mobile. This increases the number of charge carriers and has a direct effect on the resistivity or conductivity of the semiconductor material. For a uniform semiconductor, the resistance in $\Omega$ is:

$$R = \frac{\rho L}{w t} = \frac{L}{w t} \sigma$$  \[3-2-1\]

Where $L$ is the length (cm), $w$ is the width (cm), $t$ is the thickness (cm), $\rho$ is the resistivity ($\Omega$-cm), and $\sigma$ is the conductivity ($\Omega$-cm)$^{-1}$. The conductivity can be shown as:

$$\sigma = \eta \mu_n + q \rho \mu_p$$  \[3-2-2\]
Where q is the charge of an electron (C), n and p are the concentrations of electrons and holes, respectively, \( \mu_n \) and \( \mu_p \) are the electron and hole mobilities (cm\(^2\)/V-s), respectively. The electron and hole mobility is described as:

\[
\mu_n = \frac{q t m_n^*}{l_n} \\
\mu_p = \frac{q t m_p^*}{l_p}
\]  

[3-2-3]  

[3-2-4]

Where \( t \) is the mean free time between scattering collisions (s), and \( m_n^* \) and \( m_p^* \) are the effective masses of an electron and a hole (kg), respectively.

When light impinges on the semiconductor, electron-hole pairs are generated which change the material conductivity. Figure 3-2-5 shows the excitation (a), lattice scattering (b) and recombination (c) of an electron in a semiconductor band structure.

![Diagram showing the excitation and recombination of an electron in a semiconductor](image)

Figure 3-2-5 Diagram showing the excitation and recombination of an electron in a semiconductor (adapted from Streetman & Banerjee, 2000).

When an external electric field \( \xi_x \) is applied to the semiconductor in the x direction, the electrons experience a net force of \(-q\xi_x\). If \( p_x \) is the x component of the total momentum of n electrons, the force of the electric field on n electrons is:

\[-nq\xi_x = \frac{dp_x}{dt} \]  

[3-2-6]

The electrons and holes then move in opposite directions, leading to a flow of current (Singh, 1994). The current in the x direction due to the flow of electrons and holes is:
A bias potential applied along the length of the semiconductor provides the electric field that will separate the electron-hole pairs. Light then needs to impinge on the semiconductor's surface. This light must be of an energy high enough to excite the electron to a state where it has sufficient energy to move to the conduction band. The increase in charge carriers in the conduction band reduces the resistance so that a larger current can flow in an external circuit. The change of conductivity due to impinging light where both holes and electrons are present is be given by:

\[ J_x = q(n\mu_n + p\mu_p)\xi_x = \sigma\xi_x \]  

[3-2-7]

Where \( q \) is the magnitude of the electronic charge (C), \( \delta_p \) and \( \delta_n \) are the excess hole and electron concentrations (cm\(^{-3}\)), \( \mu_n \) and \( \mu_p \) are the electron and hole mobilities (cm\(^2\)/V-s).

When considering semiconductors in such technology as solar cell applications, measuring the photoconductivity can be a very useful tool. Many important characteristics can be determined about the semiconductor, including conductivity which is directly related to carrier recombination life time under different intensities of illumination, and the effect of doping on the e-h pair generation under illumination. This type of information could go a long way in helping to determine the best dopant levels to use (Streetman & Banerjee, 2000).

\[ \Delta\sigma = q\delta_p\mu_p + q\delta_n\mu_n \]  

[3-2-8]

**3-3 Atomic Force Microscopy**

Atomic Force Microscopy (AFM) is used to perform surface imaging with atomic resolution. The atomic force microscope works by measuring the force between the surface of the sample and the scanning tip of the microscope. This force is typically very small, usually less than \( 10^{-9} \) Newtons. The forces in question are not measured directly by the microscope. Instead, the deflection of a microcantilever attached to the scanning tip is measured which gives an indication of the force. There are two main atomic force microscope classifications or modes of operation, repulsive (contact mode) and attractive (non-contact mode).
3-3-1 Operation
The operation of the microscope is fairly simple, the schematic diagram of an AFM is shown in Figure 3-5-1. An atomically sharp tip, usually composed of Si₃N₄ or Si, is scanned over the surface of the sample. The microscope has a feedback system that makes it possible for scanners to keep the tip at a constant height. This provides force information about the surface. The detection system on the atomic force microscope has relatively few moving parts. First a reflective cantilever can be positioned over the sample. The scanning tip is attached to the underside of this cantilever. A laser beam is then focused onto the top reflective side of the cantilever. The reflected beam is redirected via a mirror to a dual element photodiode, which measures the difference in light intensities and converts it to a signal voltage. Data collected from this information enables three dimensional topographical maps to be constructed showing the surface detail. There are three modes of operation, contact mode, non-contact mode, and tapping mode which can be considered intermittent contact.

3-3-2 Contact Mode
In contact mode, the tip is used to scan the surface in close contact. Figure 3-5-2 shows the position of the probing tip with respect to the sample’s surface. This is the most common mode of operation. The force produced on the tip is a repulsive force with a mean value usually around $10^{-9}$ Newtons. In this mode, a piezoelectric positioning element is used to set the force. It does this by pushing the cantilever against the
surface. The deflection of the cantilever can then be measured and a comparison can be made in a feedback amplifier. When there is a difference in deflection the feedback amplifier can be used in conjunction with the piezoelectric positioning element to provide small height adjustments to the sample relative to the cantilever, which will act to maintain a constant deflection value.

Figure 3-5-2 Position of cantilever and probe in contact mode (adapted from Hong-Qiang 1997).

3-3-3 Non-Contact Mode
The non-contact mode is used when contact of the tip with the sample can cause problems. The tip is placed about 50 to 150 angstroms above the sample surface, as shown in Figure 3-5-3. In this mode of operation, the forces being measured are the attractive Van der Waals forces acting between the sample and the tip. The forces present in this mode are markedly weaker than those present in contact mode. The other main difference between this mode and contact mode is that AC detection methods are used so the tip has to oscillate. The data collected from this mode of operation can be used to construct topographical information about the sample’s surface.
3-3-4 Tapping Mode

Tapping mode is used when problems such as friction, adhesion, and electrostatic forces need to be avoided. Using a piezoelectric crystal, the cantilever oscillates near its resonant frequency with an amplitude usually greater than 20 nm. The oscillation frequency is between 50kHz and 500kHz. The oscillation of the cantilever is kept constant by means of a feedback loop. When the cantilever comes in close proximity with the surface, the amplitude of the oscillation is reduced. This reduction in amplitude is measured and used to determine the aspects of surface features (Hong-Qiang, 1997). Figure 3-5-4 shows the oscillation of the probe with respect to the surface of the sample.
Regardless of the mode used to gather data, the AFM simply provides topographical information of the surface detail present. Most AFMs come with analysis software that can use this information to determine information such as grain size and surface roughness.

**3-4 Proton Induced X-ray Emission**

Proton Induced X-ray Emission (PIXE) is an excellent non-destructive analytical technique for quantifying and identifying elements in trace amounts. The technique is suitable for detection of the elements ranging from Aluminium to Uranium. The sensitivity of the instruments used typically ranges from 1-100 ppm. It is also important to note that PIXE only probes 10 to 50μm into the surface of the sample.

The technique involves targeting a beam of protons at the surface of the sample being examined. The protons lose energy to electrons as they move through the sample material. Excited electrons, particularly the K and L shell electrons, gain enough energy to be ejected resulting in an unstable electronic configuration. Electrons in higher shells fall down to replace the lost electrons and in doing so give off energy in the form of X-rays. This process is shown in Figure 3-6-1. Also, Figure 3-6-2 shows the typical arrangement of an accelerator and detectors used for PIXE.

Each element in the periodic table emits X-rays characterised by specific energies. By examining the spectrum of X-ray energies given off, one can determine the different elements present and their concentrations. A list of elements and their characteristic X-rays has been placed in Appendix D. PIXE is a bulk analysis process where a comparatively large area of the sample is observed as a whole. This can be compared to SIMS where the analysis is conducted on a relatively small area of the sample and is taken relative to depth.
Figure 3-6-1 Proton induced X-ray emission.

Figure 3-6-2 Schematic of equipment used for PIXE. (Adapted from ANSTO. 2002).
3-5 Secondary Ion Mass Spectroscopy

Secondary Ion Mass Spectroscopy (SIMS) is a surface analysis technique used to determine information about the surface composition of a wide range of solid surface materials. Both quantitative and qualitative measurements are possible with the SIMS technique. Quantitative measurements require a standard reference sample to calibrate the equipment. Qualitative measurements require no reference sample and can be utilised to make comparisons of relative compositions between samples. SIMS can perform an analysis of species with a possible mass range of 1-500 amu, with a resolution in mass of $\Delta M/M = 10000$. These properties make SIMS an ideal technique for determining the relative quantities of possible trace elements and trace impurities that have been deliberately introduced through doping in the surface or near surface layers of solid surface materials.[8]

SIMS works by accelerating, collimating, and focussing a beam of ions called the primary beam onto a sample. The ions used have energy typically in the order of 100-10,000 eV. This quantity of energy is used to sputter atoms and molecules from the surface of the samples being examined, as shown in Figure 3-7-1.

![Cs ion beam and ejected sample ions.](image)

This examination technique is quite destructive to the surface of the sample. In fact, there will be no film left at the spot being probed when the SIMS analysis is complete. The range of ejected particles have a number of states extending from a positive charge, to neutral, to a negative charge. Those particles present with a charge are called secondary ions. These ions are channeled through a column and measured with a mass...
spectrometer (Burke et al., 2002). The information concerning the collected ions mass and charge are then sent to a computer workstation where it can be collected, stored and manipulated as needed.

Typical SIMS has a spatial resolution of 2-5μm, a depth resolution of 1-2nm, and a detection limit in the range of parts per million to parts per billion. Depth profiling is possible to a depth of up to 10μm and elemental mapping of areas up to 500x500μm² (Burke et al., 2002).

**3-6 Environmental Scanning Electron Microscopy**
The Environmental Scanning Electron Microscope (ESEM) is a Variable Pressure type Scanning Electron Microscope (VP_SEM). This means that the pressure in the analysis chamber is dynamic, it can be changed. This type of microscope can accommodate several different types of detectors such as Secondary Electron Detectors and Back Scattered Electron Detectors. The microscope incorporates several pressure limiting apertures that keep the pressure in the column constant while allowing the pressure in the chamber to be changed (see Figure 3-8-1). An important difference between this type of microscope and a normal SEM is that insulating as well as conducting samples can be viewed without applying a conducting coating (Griffin, 2001).

![Figure 3-8-1 ESEM vacuum system design](image)
3-6-1 Secondary Electron Detector
Conventional Secondary Electron Detectors can not be used in a VP_SEM. The relatively high pressure of gas in the analysis chamber, combined with the scintillator bias, causes arcing. Instead, the Danilatos model is used where a positively charged detector attracts a signal. The signal is amplified by a reaction between the secondary electrons and the gas particles that causes an electron cascade. The charge created on the sample by the primary electron beam is cancelled by the flood of positive ions created by the interaction of the secondary electrons with the gas (Griffin, 2001). This process is shown in Figure 3-8-2.

![Diagram of Amplification of electronic signal](adapted from Griffin, 2001)

3-7 Charge Contrast Imaging
Charge Contrast Imaging (CCI) is brought about by charging effects that manifest themselves as differences in contrast in an image. CCI has applications in material imaging, defect imaging, and in examining film contaminates and defects. Information gained from CCI exhibits a close correlation with that gained from Cathodoluminescence. It should be noted that conventional coating of samples with conducting layers such as Gold and Carbon is not required and will in fact prevent imaging via the CCI technique.

There are a number of problems associated with CCI. Firstly, the surface of the material can experience some contamination during analysis. Secondly, the primary electron beam will experience some scattering which can lead to a reduced spatial resolution.
The contrast in a CCI image is stable at constant operating conditions and is reproducible. However there are a few factors that the system can be sensitive to, such as electron beam current, chamber pressure, PLA size, scan rate, working distance, and ESD grid bias. The system is also found to be relatively impartial to the accelerating voltage, although it can have a small effect on the contrast in the image and the surface state, whether it be polished, scratched, or cracked.

Optimum conditions can be obtained for examining most samples, however, if the chamber pressure is too high, the contrast in the image will convert back to the conventional Secondary Electron detail. If the chamber pressure is too low, the contrast in the image will convert to a surface charging effect. It is useful to compare the images obtained from the CCI process and that of the normal Secondary Electron (SE) process. The primary difference observed when comparing a CCI and a SE image is the decreased resolution in the CCI. This is a product of having a higher pressure in the analysis chamber in the VP_SEM. Despite the decreased resolution, the CCI process is still extremely useful as it can view insulating samples that the SE process cannot, and can differentiate regions of the sample by their charge content. This should make CCI ideal for imaging semiconductor materials and devices (Gluszak & Hinckley, 2001; Griffin, 2001).
4-1 Chemical Bath Deposition
The Chemical Bath Deposition (CBD) process is one of the simplest and cheapest processes with which to create thin film structures such as CdS thin films. The CBD process basically involves the submersion of substrates in a solution containing a chemical system that will deposit a film onto the substrate surface. The entire process revolves around the composition of the chemical bath. The constituents of the chemical bath create a precipitate that deposits on the substrates. Various aspects of the process such as temperature, concentration of the various chemical constituents, and deposition time can be manipulated to control the characteristics of the deposited thin film.

4-1-1 Background
Former student Edward A. Gluszak designed the first apparatus in 1996 (Gluszak, 1996), shown in Figure 4-1-1-1. The apparatus incorporates a water bath heated by a 500ml electrothermal heating mantle, a thermocouple temperature controller linked to the heating mantle, and an electric motor with stirrer connected to a ceiling fan controller for speed control. Substrates are held in place in a 250ml beaker which is used as the reaction vessel in the water bath.

Figure 4-1-1-1 Edward Gluszak’s Experimental Apparatus (adapted from Gluszak, 1996).
This experimental apparatus, as functional as it is, has several areas that needed development to increase its efficiency and ease of operation. First, the reaction chamber, reagents and slides are open to the outside system. This poses two problems, possible contamination with outside particulate sources and thermal instability. Since the system is open, thermal energy can easily escape, which in turn provides problems when trying to maintain a constant reaction temperature. Enclosing the reaction vessel in polystyrene and foam can easily solve this problem. This closes the system off from any contaminants and prevents most of the thermal energy from escaping. Second, the stirring device, although very efficient, is providing a path for thermal energy to escape as it is made of metal. This device was replaced with a magnetic stirrer and magnetic flea. The magnetic stirrer, also being more appropriately designed for the task, provides more control over the state of agitation in the reaction vessel. Finally, with the reaction vessel enclosed in polystyrene, the electrothermal heating mantle is no longer useful as it would melt the polystyrene. For this reason it is replaced with heating coils inside the polystyrene jacket and a preheating stage in the production process for reagents.

4-1-2 Current Experimental Apparatus
The experimental apparatus used in this study is shown in Figure 4-1-2-1, and consists of an 800ml beaker wound with coils of wire that are connected to an IEC CAT No 2633-001 DC power supply. The coils are not used to heat the contents from room temperature. Instead, reagents are preheated then transferred to the reaction chamber. The coils are then used to maintain an appropriate temperature. However the heating coils can be used to increase the temperature by small amounts, although temperature increases of anything more than 5 or 10 degrees Celsius take too long, as the heating coils are not very powerful. The beaker has several layers of cell air foam wrapped around it and is inserted into a polystyrene jacket. The jacket has an inner and outer lid that seal shut during the operation of the system. Encasing the reaction chamber in insulating foam prevents the heat from escaping so that only small amounts of energy are required to maintain the temperature of the reaction system. Situated in the lid is a plug that allows for easy access to substrate slides and thermocouple. This also allows for the addition of chemical reagents. The type-T thermocouple is connected to a BC BTC-2220 thermocouple controller which is linked to the power supply for the purpose of monitoring and controlling the temperature. The whole system is then situated on an IEC CAT No 76083v hot plate-stirrer. No heat is required from the hotplate, and the
magnetic stirrer is used to sufficiently agitate the reagents throughout the whole process. This ensures that the chemical reagents remain uniformly mixed and provides an even deposition on the substrates.

![Experimental Apparatus](image)

**Figure 4-1-2-1** Experimental Apparatus used to deposit films in this study.

**4-1-3 Experimental Technique**
The technique employed to produce the thin films is quite simple. Firstly the hot plate, power pack, thermocouple and reaction chamber are set up. The reaction chamber and thermocouple are then cleaned with a concentrated sulfuric acid solution to remove any contaminants, and then rinsed with Milli-Q water. The substrates onto which the film will be deposited are cleaned in a bath of concentrated sulfuric acid for 30 minutes, then
rinsed in Milli-Q water and positioned in their holder to be placed into the reaction chamber. The substrates were standard glass microscope slides. An optimum concentration of the CBD constituents was predetermined from previous work and stock solutions were prepared. 350 mL of Milli-Q water is then preheated to 10°C above the determined reaction chamber temperature, the water is added directly to the reaction chamber and the heating coils engaged. 42 mL of 17 ML\(^{-1}\) ammonia solution is then added to the system and is allowed to equilibrate for 10 minutes. When the desired reaction chamber temperature is reached, 4 mL of 0.2 ML\(^{-1}\) Cadmium Acetate Dihydrate (Cd(CH\(_3\)COO)\(_2\).2H\(_2\)O) stock solution reagent is added, and the system is again allowed to equilibrate for 5 minutes. Finally 4mL of 0.4 ML\(^{-1}\) Thiourea (H\(_2\)NCSNH\(_2\)) stock solution reagent is added, the reaction chamber is then closed up and deposition time begins. Some of the films had Indium dopant, which was accomplished by adding a very small volume (<2mL) of Indium III Chloride Tetrahydrate (InCl\(_3\).4H\(_2\)O) 0.004 ML\(^{-1}\) stock solution just after adding the Cadmium Acetate Dihydrate.

4-1-4 Post Deposition Processing
Post deposition processing is a straight forward task where the slides are cleaned, and if need be, annealed. When the deposition is completed, the substrate slides are extracted carefully so as to not damage or contaminate the films, and rinsed in Milli-Q water. They are then placed in an ultra-sonic cleaner with Milli-Q water for 30 minutes. The slides are then removed, rinsed with more Milli-Q water, and allowed to dry in air. Depending on the desired characteristics of the films, annealing was conducted. The slides are placed in stainless steel racks and put into an Analite Model 4 furnace at an optimum temperature of 400°C for a period of 60 minutes, with an air atmosphere. An air atmosphere was chosen because the Oxygen is substituted for the Sulfur in the CdS lattice, which has the effect of increasing the n-type nature of the thin film and enhancing the conductivity. When the anneal process is completed the slides are extracted and allowed to cool slowly in air. The cooled the slides can then be cut with a straight edge and glass cutter to sizes more appropriate to experimentation. Special care is taken not to contaminate the slides with finger prints or latex while cutting.
4-2 Secondary Ion Mass Spectroscopy
SIMS measurements were performed at the Australian Nuclear Science and Technology Organisation (ANSTO) under a grant from the Australian Institute of Nuclear Science Engineering (AINSE). The SIMS used was a Cameca brand ims5f magnetic grid SIMS. This was interfaced with a Sun Microsystems computer used to capture and process data.

4-2-1 Sample Preparation
The slides produced in the Chemical Bath Deposition are too large to mount in the analytical chamber of the SIMS. The samples therefore have to be cut down significantly. A number of samples can be mounted at one time on a number of different mounts. These mounts are the same size but have different viewing window configurations of 3, 9, 14 and 18 requiring increasingly smaller sample sizes. Glass slides are not easily cut to very small sizes so the 3 window sample mount was used. While cutting the samples to size it is important to remember to keep them as contaminant free as possible. Oily finger prints provide the most trouble as they can lead to very long pump times when evacuating the analytical chamber. Several precautions were taken to combat this. Firstly, a clean operating environment was used to process the slides. Secondly, gloves were worn to prevent the contamination of the slides with any dirt or oil. And lastly, if any contamination was present, an alcohol solution was used to clean the slide prior to mounting it. The mounting procedure is very simple, the precut samples are placed in the holder with the analytical surface down and a spring loaded backing plate is screwed on top to hold them in place. A schematic of the sample holder used can be found in Appendix C, within the sample preparation guide provided by ANSTO.

4-2-2 Analysis
The analysis of the samples was conducted with a Cs⁺ source. Only the relatively thick samples provided usable results as the thin samples experienced surface charging as they were bombarded with the Cs⁺ ions. The surface charging caused the analytical beam to deflect. It was also found that in the thin samples, the beam sputtered through the CdS surface to the glass very quickly and then the glass surface charge deflected the beam, also giving unreliable data. Despite these problems, useful data was acquired from a good number of slides. Several relevant elements were examined, including
oxygen, silicon, sulfur, arsenic, cadmium and indium. The results provide a qualitative comparison of the elemental composition between the samples. To perform a quantitative analysis a standard was required to calibrate the SIMS hardware. However, no CdS or In standard samples were available at the time of analysis. Despite this good quality results were obtained for the qualitative analysis.

4-2-3 Charge Compensation
To compensate for the charging on the surface of the very thin samples, two techniques were employed. A gold coating was applied to the surface of the sample using a gold sputter coater. This functions to improve the conductivity near the surface of the sample so charge that builds up where the analytical beam hits the sample surface can be dissipated more quickly. The second technique is to use an electron gun focused at the area being examined to compensate for the charge buildup. This technique was employed to examine a variety of the thinner more troublesome samples with and without gold coatings, however, the quality of result achieved was still far from acceptable.

4-3 Atomic Force Microscopy
AFM measurements were conducted at ANSTO under a grant from AINSE. At the time PIXE measurements were to be carried out, however, this equipment was unavailable, as a result time with the AFM was supplied as a temporary substitute. The type of AFM used was a Digital Instruments Nanoscope IIIa.

4-3-1 Analysis
The analysis of the samples was conducted in the contact mode of operation. Firstly, a suitable area of film was selected that had a consistent coating of CdS. Then images were taken at sizes of 50, 10, and 5 µm. When the AFM had finished compiling the image into a tiff file it was flattened to remove any tilt brought about by uneven orientation of the sample when it was mounted and again saved as a tiff file. The flattened images were later examined with the off line software supplied by Digital Instruments. The off line software required a Pentium computer with Microsoft Windows NT 4.0 operating system installed. Three dimensional plots of the surface were then constructed.
4-4 Charge Contrast Imaging
CCI images were taken at the Centre for Microscopy and Microanalysis at the
University of Western Australia (UWA) using an Electroscan Environmental Scanning
Electron Microscope. The use of the facilities at UWA were facilitated via the Western
Australian Centre for Microscopy (WACM) agreement.

4-4-1 Sample Preparation
Unlike other SEM's, the ESEM requires very little sample preparation. Usually samples
that have a high resistivity such as CdS are required to have a conductive coating such
as carbon or gold. However, this is not needed due to the ESEM's unique operating
conditions. Slides were required to be cut to a small size to fit on the stage
approximately 2cm square or smaller. Samples were then adhered to the stage with
carbon tape.

4-4-2 Analysis
Analysis of the CdS thin films was conducted at a relatively low chamber pressure of
between 1.5 and 3 Torr and the medium sized bullet aperture was used. The accelerating
potential was set to the highest setting available, 30keV. The working distance was set
to approximately 5mm to provide a good resolution at higher magnifications. A spot
size of 30 was also selected which means only 30% of the analysis beam was wasted. A
secondary electron detector was used to measure the electrons that were emitted. Once a
suitable image was acquired it was sent to a computer that captured them and saved the
images as tiff files. The images could than be transferred to the image analysis lab and
manipulated to maximise the detail quality.

4-5 Proton Induced X-ray Emission
PIXE measurements were conducted at ANSTO under a grant from AINSE using the
SR-2 3MV accelerator facility. At the time PIXE measurements were to be carried out,
however, this equipment was unavailable, as a result staff at the ANSTO facility were
supplied with a selection of samples to be examined at a later date.
4-5-1 Analysis
Samples such as the CdS thin films require no sample preparation for examination with PIXE. The samples are simply mounted on a sixty sample slide and the equipment is set to automatically test each one. The X-ray lines for each of the elements Sulfur, Cadmium and Indium were examined to determine their concentrations in the thin films. The determination of the concentrations of Cadmium and Indium was done using the L X-ray lines which happen to overlap. Along with beam stability problems, this has resulted in some anomalous values due to the analysis software being unable to resolve the interference.

4-6 Electrical Measurements
Electrical measurements were carried out using a simple series resistance circuit and a multimeter. A 1.5 V battery and 30 MΩ resistor were connected in series with the CdS thin films. The CdS thin film was contacted to the circuit with Indium to ensure an ohmic connection. The distance between the two connections on the CdS thin film was 10mm. The potential across the 30 MΩ resistor was then measured with a Hewlett-Packard 34401A Multimeter. A schematic of the circuit is shown in Figure 4-6-1.

![Figure 4-6-1 Circuit used for electrical measurements.](image)

4-6-1 Analysis
In analysing the CdS thin films, two measurements were taken of the potential across the 30 MΩ resistor with the sample in the dark and under light sources. The CdS sample
was illuminated with two different light sources, a flash light and strobe which is much more powerful. This was to give an idea of the effect of different amounts of illumination. Once the information was gathered the resistance for the sample could be calculated using Ohm’s Law:

\[ V = IR \]  

The objective here is to compare the conductive properties between samples, and in the dark and under illumination. This is just a qualitative analysis, not quantitative one.
RESULTS

5-1 Chemical Bath Deposition
A variety of slide deposition conditions were used and samples were grown using the CBD method. Several variables were altered to produce an even spread of electrical, optical and compositional properties to examine. Table 4-1-1 below identifies each sample with its deposition conditions.

<table>
<thead>
<tr>
<th>Sample</th>
<th>Deposition Temperature (°C)</th>
<th>Indium Dopant Concentration in Deposition Solution (%)</th>
</tr>
</thead>
<tbody>
<tr>
<td>04A,B,C</td>
<td>60</td>
<td>0</td>
</tr>
<tr>
<td>04D,E,F</td>
<td>60</td>
<td>0</td>
</tr>
<tr>
<td>05A,B,C</td>
<td>70</td>
<td>0</td>
</tr>
<tr>
<td>05D,E,F</td>
<td>70</td>
<td>0</td>
</tr>
<tr>
<td>06A,B,C</td>
<td>80</td>
<td>0</td>
</tr>
<tr>
<td>06D,E,F</td>
<td>80</td>
<td>0</td>
</tr>
<tr>
<td>07A,B,C</td>
<td>60</td>
<td>1</td>
</tr>
<tr>
<td>07D,E,F</td>
<td>60</td>
<td>1</td>
</tr>
<tr>
<td>08A,B,C</td>
<td>70</td>
<td>1</td>
</tr>
<tr>
<td>08D,E,F</td>
<td>70</td>
<td>1</td>
</tr>
<tr>
<td>09A,B,C</td>
<td>80</td>
<td>1</td>
</tr>
<tr>
<td>09D,E,F</td>
<td>80</td>
<td>1</td>
</tr>
<tr>
<td>10A,B,C</td>
<td>60</td>
<td>0.1</td>
</tr>
<tr>
<td>10D,E,F</td>
<td>60</td>
<td>0.1</td>
</tr>
<tr>
<td>11A,B,C</td>
<td>70</td>
<td>0.1</td>
</tr>
<tr>
<td>11D,E,F</td>
<td>70</td>
<td>0.1</td>
</tr>
<tr>
<td>12A,B,C</td>
<td>80</td>
<td>0.1</td>
</tr>
<tr>
<td>12D,E,F</td>
<td>80</td>
<td>0.1</td>
</tr>
<tr>
<td>13A,B,C</td>
<td>60</td>
<td>0.01</td>
</tr>
<tr>
<td>13D,E,F</td>
<td>60</td>
<td>0.01</td>
</tr>
<tr>
<td>14A,B,C</td>
<td>70</td>
<td>0.01</td>
</tr>
<tr>
<td>14D,E,F</td>
<td>70</td>
<td>0.01</td>
</tr>
<tr>
<td>15A,B,C</td>
<td>80</td>
<td>0.01</td>
</tr>
<tr>
<td>15D,E,F</td>
<td>80</td>
<td>0.01</td>
</tr>
</tbody>
</table>

The Cadmium Acetate, Thiourea, and Ammonia concentrations were kept constant at 2mM/L, 4mM/L, and 1.8M/L respectively. The reaction chamber temperature, and Indium concentration were the two main variables of concern. Four reaction chamber Indium concentrations of 0%, 0.01%, 0.1% and 1% were chosen in conjunctions with
three reaction temperatures of 60, 70 and 80°C. This provided a range of 12 different slide compositions and production conditions. Six of each slide were manufactured providing seventy two slides in total. Half of each type of slide, those labeled A, B, and C was then annealed in air which in turn provided twenty four different slides each in triplicate to allow for different testing requirements.

5-2 Visual Analysis
The reaction chamber temperature seemed to have a direct effect on the surface characteristics. Shown in Figure 5-2-1 are three samples that are as-deposited with 0% Indium doping, produced at 60, 70 and 80°C.

![Figure 5-2-1 As Deposited CdS Thin Films with 0% Indium doping.](image)

As can be seen from a visual inspection, the slide labeled 04F produced at 60°C has a relatively even coating of CdS. Slide 05F produced at 70°C appears much darker which suggests a much thicker coating of CdS and the coverage of the slide is still relatively even. Slide 06F has a slightly darker appearance than 04F but not as dark as 05F, indicating a thickness somewhere in between. However it is worth noting that the coverage of CdS is poor at best with large areas having no deposit at all. This can be attributed to the change in dominance of the two systems by which CdS is being
formed. During the deposition there is an ion by ion deposition and a particulate formation taking place. The ion by ion deposition produces the desired smooth crystalline deposits on the substrates, and the particulates are formed in the solution. At higher temperatures the CBD system was observed to favour the formation of particulates, so that there are less reactants left for the ion by ion deposition.

The annealing process also had a marked effect on the visual appearance of the slides. Shown in Figure 5-2-2 are slides from the same subset as above only they are annealed.

![Figure 5-2-2 Annealed CdS Thin Films with 0% doping.](image)

It can plainly be seen here that the coverage of cadmium sulfide is the same as in the as-deposited counterparts, only the color of the film has changed quite significantly. Instead of a yellow brown we have a very distinct orange brown color. This can be attributed to the change in elements and compounds present. Sulfur present on the substrate has a yellow colour, this element can be diffused out of the film in the annealing process. This decreases the intensity of the yellow colour in the films. During the annealing process oxygen is diffused into the film which may combine with the Cadmium to form Cadmium(II) Oxide which has a brown colour. These two factors
combined with Cadmium Sulfides yellow-orange colour turn a yellow orange as-deposited film into an orange brown annealed film.

5-3 Secondary Ion Mass Spectroscopy
The SIMS data was organised in an ASCII text file in the form of a depth profile. The data gives information on the relative quantities of elements present with respect to the probing depth. Files from the SIMS computer include a summary of the operating conditions and two columns of data for each element, one for the time and the other showing counts per second. The data gives an indication of the relative quantities of elements present between samples, however a comparison cannot be made between elements. The data also indicates the relative sample thickness between samples as a product of how long it took to sputter through to the glass substrate. This is indicated where the concentration of elements present starts to drop off sharply. However, this is only of marginal interest as only a very select range of samples was examined. The raw data in the ASCII files has been converted into a graphical format for analysis. An example of the raw data can be found in Appendix B.

While examining the films with the SIMS technique, some difficulty was experienced with samples that had very thin films. Those films produced at 60°C were exceptionally thin and as a result surface charging occurred, this interfered with the acquisition of any usable data for these slides. Those films produced at 80°C had a suitably thick film to be examined without charging, but were patchy so care had to be taken in selecting an appropriate area for examination. Films produced at 70°C had a consistent covering of the slide and were of an appropriate thickness to avoid any charging complications. For this reason the analysis has concentrated on the films produced at 70°C.

An analysis of graphical data reveals many relevant details concerning the annealing and doping of the CdS films, as well as trace impurities and relative film thickness. A comparison of the annealed samples 05C, 08C, 11C and 15C with the as-deposited samples 05D, 08D, 11D and 15D shows there is approximately 10 times the quantity of Oxygen present in the annealed samples. This indicates that during the post deposition processing when the films were annealed in air, oxygen permeated the crystal structure.
of the films. The quantities of Cadmium and Sulfur present in both the annealed and as-deposited samples is very similar. This can be seen in Figures 5-3-1 through 5-3-8.

By making a comparison of the graphical data, the effect of Indium doping on the CdS film composition can be seen. It is important to note that in the production of the films, the concentration of Indium in the chemical bath solution was 0% for 05C and 05D, 1.0% for 08C and 08D, 0.1% for 11C and 11D, 0.01% for 15C and 15D. Films 08C and 08D show approximately 10 times the amount of Indium present than in films 11C and 11D. Films 15C and 15D show 10 times less Indium again than that found in films 11C and 11D. However the Indium present in 11C and 11D is so low that it would be very difficult to distinguish it from the levels present in films 05C and 05D, which have only trace impurities present.

It is also worthwhile to note that the concentration of Indium in the films varies as a function of depth. The concentration of Indium increases as you probe deeper into the film. This is likely due to the concentration of Indium in the chemical bath solution decreasing as it is used up in being deposited on the substrates. It can be determined from Figure 5-3-9, a plot of the Indium concentrations in the different samples, that the annealed films tend to have slightly higher concentrations of Indium present. The SIMS results do not show any difference in the distribution of Indium as a function of depth in the annealed as compared to the as-deposited films. From the data it can also be seen that there are trace amounts of Arsenic present in the films. This is most probably due to Arsenic trace impurities present within the Cadmium reagent.
Figure 5-3-1 SIMS for sample 05C.

Figure 5-3-2 SIMS for sample 05D.
Figure 5-3-3 SIMS for sample 08C.

Figure 5-3-4 SIMS for sample 08D.
Figure 5-3-5 SIMS for sample 11C.

Figure 5-3-6 SIMS for sample 11D.
Figure 5-3-7 SIMS for sample 15C.

Figure 5-3-8 SIMS for sample 15D.
Figure 5-3-9 Comparison of Indium component as a function of depth (sputter time).

Figure 5-3-10 Comparison of Cadmium component as a function of depth (sputter time).
Figure 5-3-11 Comparison of Sulfur component as a function of depth (sputter time).

Figure 5-3-12 Comparison of Oxygen component as a function of depth (sputter time).
5-4 ESEM Charge Contrast Imaging

The CCI data was presented in the form of tiff image files. The images are in black and white and show areas of varying charge. The closer to white, the higher the charge. Surface detail can also be seen on the images. These images show the presence of different defects and structures that are present. Two images are shown for each sample, one with a relatively wide field of view and a close up.

When examining the images several important observations can be made concerning the post deposition processing of the films, and processes present during the deposition of the films. Firstly, all the annealed films have bright spots with an approximate size of 1μm covering the surface of the films. These bright spots appear to be charging significantly more than the rest of the film. The as-deposited films generally do not have these bright spots present at all. This indicates that during the annealing process some crystalline structures have formed at the surface of the film, that may have different chemical compositions to the rest of the film.

Secondly, there also appears to be small particulates present on the films surfaces that can be seen as small charging spots with irregular often jagged shapes. This would appear to be the second type of film deposition where colloidal particles of CdS adhere to the surface. An example of this can be seen in sample 07D shown in Figures 5-4-15 and 5-4-16.

Lastly, samples 06 and 09 shown in Figures 5-4-11 and 5-4-21 through to 5-4-24, which were produced at 80°C, show an inconsistent surface where not all of the glass substrate is covered. This can be seen where a smooth surface that charges differently to the rest of the film appears. Some areas of these films also show deposits of particulates stuck to the surface of the films. This indicates a decrease in the ion by ion deposition reaction, and an increase in the particulate formation. The incomplete coverage of the substrates here and in other samples shown in Figures 5-4-22, 5-4-23, 5-4-41 indicate that ion by ion deposition does not occur with sufficient frequency to cover the entire slide with an adequate film.
Figures 5-4-23 and 5-4-24 are excellent examples of the initial stages of film growth where the edge of the thin film is still growing and has not yet joined to close gaps over the substrate. Figure 5-4-5 shows the contrast effect of two different phases in the CdS thin film, one as Grey surface with white dots and the other a brilliant white patch. An excellent example of a short circuit effect can be seen in Figure 5-4-19 where a scratch in the surface of the film is preventing the charge in the film from dissipating into the right side of the image.

Figure 5-4-1 Sample 04C

Figure 5-4-2 Sample 04C

Figure 5-4-3 Sample 04D

Figure 5-4-4 Sample 04D
5-5 Atomic Force Microscopy

The AFM data was arranged in raw data files. To analyse these data files the Digital Instruments offline AFM software was required. When analysed with the offline software the data is represented as two images, the left image is a height profile of the point of the surface being examined. The right image is a difference map of the first image. Also, below the images is a summary of the examination conditions, most importantly the size of the image is shown here. Two images are shown for each of the samples that were examined, they are in Figures 5-5-1 through to 5-5-24. The first pair of images is of a relatively wide area of 50µm, the second is a close up at 5µm. A second set of images is also given in Figures 5-5-25 through to 5-5-36. These images are a three dimensional plot of the 5µm images presented. They give a clear indication of the vertical distribution of the films surface features. The three dimensional images were constructed by manipulating the data with the offline analysis software.
When inspecting the images produced by the AFM one important aspect that recurs throughout the data is the presence of nodule like structures at the surface of the annealed films. This can be seen very clearly in sample 04B in Figures 5-5-1 and 5-5-2. The nodules appear to be approximately 1μm in diameter, and using Figure 5-5-25, they are a little over 200nm high. These nodule like structures do not appear on the as-deposited films. This would suggest that the nodules develop during the annealing post deposition process of the production of the samples. A comparison of the as-deposited films in Figures 5-5-1, 5-5-2 and the annealed films in Figures 5-5-3 5-5-4 clearly shows the absence of the nodule structures in the as-deposited films. This data is in agreement with that present by the CCI measurements.

Another effect of the annealing process is the increase in roughness of the grain like surface of the CdS thin films. A comparison of the as-deposited and annealed samples in Figures 5-5-31, 5-5-32, 5-5-35, and 5-5-36 clearly shows this increase in roughness. One other feature that presents itself in all the images is horizontal lines. These are not actually present on the samples but are in fact a product of the microscope tip dragging across the surface and scoring the samples, when the very point of the tip bends due to normal use it can work to produce these lines as well. This can be seen very clearly in Figure 5-5-11, where the effect is quite severe. The lines also present themselves in Figures 5-5-14, and 5-5-21 but to a much less severe degree.
Figure 5-5-1 Sample 04B

Figure 5-5-2 Sample 04B
Figure 5-5-3 Sample 04E

Figure 5-5-4 Sample 04E
Figure 5-5-5 Sample 05B

Figure 5-5-6 Sample 05B
Figure 5-5-8 Sample 05E
Figure 5-5-9 Sample 08B

Figure 5-5-10 Sample 08B
Figure 5-5-13 Sample 11B

Figure 5-5-14 Sample 11B
Figure 5-5-17 Sample 14B

Figure 5-5-18 Sample 14B
Figure 5-5-19 Sample 14E

Figure 5-5-20 Sample 14E
Figure 5-5-25 Sample 04B

Figure 5-5-26 Sample 04E

Figure 5-5-27 Sample 05B

Figure 5-5-28 Sample 05E

Figure 5-5-29 Sample 08B

Figure 5-5-30 Sample 08E
Proton Induced X-ray Emission

The data obtained from the PIXE analysis is very anomalous, this is the result of two problems. Firstly, there was significant difficulty in obtaining any beam stability, due to recent technical difficulties and maintenance problems experienced by the 3MV accelerator used. Secondly, the Cadmium and Indium concentrations were determined using the L X-ray lines. These lines overlap and in some cases the analysis software may not be able to resolve the interference between them. The data from the PIXE has been summarised in Table 5-6-1. The stoichiometry has been arranged such that the values for Cadmium are all one, and the Sulfur and Indium values have been normalised with respect to Cadmium.

Table 5-6-1 Summary of PIXE data, showing the weight fraction and stoichiometry of Cadmium, Sulfur, and Indium.

<table>
<thead>
<tr>
<th>Sample</th>
<th>Weight Fraction</th>
<th>Stoichiometry</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>Cd</td>
<td>S</td>
</tr>
<tr>
<td>04B</td>
<td>59%</td>
<td>9%</td>
</tr>
<tr>
<td>05B</td>
<td>61%</td>
<td>14%</td>
</tr>
<tr>
<td>06B</td>
<td>50%</td>
<td>12%</td>
</tr>
<tr>
<td>07B</td>
<td>50%</td>
<td>10%</td>
</tr>
<tr>
<td>08B</td>
<td>63%</td>
<td>15%</td>
</tr>
<tr>
<td>09B</td>
<td>38%</td>
<td>11%</td>
</tr>
<tr>
<td>10B</td>
<td>47%</td>
<td>9%</td>
</tr>
<tr>
<td>11B</td>
<td>75%</td>
<td>17%</td>
</tr>
<tr>
<td>12B</td>
<td>72%</td>
<td>17%</td>
</tr>
<tr>
<td>13B</td>
<td>9%</td>
<td>8%</td>
</tr>
<tr>
<td>14B</td>
<td>79%</td>
<td>14%</td>
</tr>
<tr>
<td>15B</td>
<td>75%</td>
<td>16%</td>
</tr>
<tr>
<td>04E</td>
<td>63%</td>
<td>11%</td>
</tr>
<tr>
<td>05E</td>
<td>62%</td>
<td>15%</td>
</tr>
<tr>
<td>06E</td>
<td>49%</td>
<td>13%</td>
</tr>
<tr>
<td>07E</td>
<td>32%</td>
<td>7%</td>
</tr>
<tr>
<td>08E</td>
<td>63%</td>
<td>15%</td>
</tr>
<tr>
<td>09E</td>
<td>56%</td>
<td>15%</td>
</tr>
<tr>
<td>10E</td>
<td>54%</td>
<td>10%</td>
</tr>
<tr>
<td>11E</td>
<td>78%</td>
<td>17%</td>
</tr>
<tr>
<td>12E</td>
<td>64%</td>
<td>17%</td>
</tr>
<tr>
<td>13E</td>
<td>24%</td>
<td>10%</td>
</tr>
<tr>
<td>14E</td>
<td>73%</td>
<td>16%</td>
</tr>
<tr>
<td>15E</td>
<td>73%</td>
<td>18%</td>
</tr>
</tbody>
</table>
This data indicates that there is a trend of decreasing Sulfur content in the CdS thin films with decreasing CBD temperature. This demonstrates that at higher temperatures, the Cadmium to Sulfur ratio is lower and the films have a decreased n-type nature due to less Sulfur donor levels being present in the band structure of the CdS thin films. The weight fraction stoichiometry of Indium shown in Table 5-6-1 are completely unreliable, as can be seen from samples 04 to 06 that were grown with no Indium dopant. Due to the anomalous nature of the data given by this PIXE analysis, no further determination can be made concerning the properties of the CdS thin films. It could be suggested that this analysis could be repeated when the facilities at ANSTO have been sufficiently repaired or at another facility that has more reliable equipment.

5-7 Electrical Measurements

A majority of the samples could not be electrically measured as the films were too thin or did not have a consistent coating on the substrate which in turn caused short circuit effects. The data for the electrical measurements was compiled and manipulated to give the resistance of the CdS thin samples in the dark, under illumination of a flash light, and under the illumination of a strobe light. A collection of the results under these conditions is shown in Table 5-7-1. This data gives a clear indication that the as-deposited CdS thin films have a lower resistance in the dark and under both types of illumination. The resistance does seem to decrease with increasing light intensity in both the as-deposited films and the annealed without much variation.
Table 5-7-1 Resistance measurements.

<table>
<thead>
<tr>
<th>Sample</th>
<th>Flash Light</th>
<th></th>
<th>Strobe</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>Dark Resistance Ohms</td>
<td>Light Resistance Ohms</td>
<td>Dark Resistance Ohms</td>
</tr>
<tr>
<td>05C</td>
<td>5.6.E+10</td>
<td>2.5.E+10</td>
<td>2.5E+10</td>
</tr>
<tr>
<td>05D</td>
<td>4.0.E+09</td>
<td>2.1.E+09</td>
<td>7.4E+08</td>
</tr>
<tr>
<td>08C</td>
<td>1.7.E+10</td>
<td>4.0.E+09</td>
<td>8.3E+09</td>
</tr>
<tr>
<td>08D</td>
<td>2.9.E+09</td>
<td>1.5.E+09</td>
<td>8.9E+08</td>
</tr>
<tr>
<td>11C</td>
<td>5.2.E+10</td>
<td>2.2.E+10</td>
<td>2.5E+10</td>
</tr>
<tr>
<td>11D</td>
<td>7.8.E+07</td>
<td>6.3.E+07</td>
<td>1.0E+08</td>
</tr>
</tbody>
</table>
DISCUSSION

An analysis of the SIMS data by making a comparison of depth profiles between annealed and as-deposited CdS thin films, shows the annealed films as having in the vicinity of 10 times more Oxygen present. The depth profiles also indicate that Cadmium and Sulfur present in both the as-deposited and annealed thin films is similar. The SIMS data also revealed that the comparative dopant concentrations between the CBD solution and the CdS thin film composition remained roughly constant. This is evidenced by the jump in Indium dopant concentration by a factor of almost 10 for corresponding films that had deposition solutions with Indium concentrations that differed by a factor of 10. The depth profiles constructed from the SIMS data provide evidence that suggests that the Indium concentration in the CdS thin films increases with depth as shown in Figure 5-3-9. This is presumed to be the effect of a decreasing Indium concentration left in the deposition solution as deposition of the thin films progresses.

The data in Figure 5-3-9 also suggests that annealed CdS thin films have a marginally higher Indium content than the corresponding as-deposited thin films. This may be the effect of decreasing Cadmium and Sulfur concentrations in the annealed films. It could also be an artifact of the SIMS analysis system where the annealed films sputter inconsistently compared to the as-deposited films.

Images obtained from CCI have indicated the presence of a protruding structure on the surface of the CdS thin films. These structures are, for the majority of cases, only present in the annealed films, and appear as bright spots that contrast quite clearly with the surrounding surface material. The size of the structures varies but are usually in the
region of ≤1μm across. Images from the AFM analysis also show nodule like structures present in the CCI analysis at the surface of the annealed CdS thin films, as shown in Figures 5-5-1 and 5-5-2. The data shows the nodules to be of a size of approximately 1μm across. The three dimensional surface plots constructed from the AFM images show the nodules to be in the vicinity of 200nm in height. These structures can not be attributed to the Indium doping as the nodules occur in both the doped and undoped films. This suggests that the structures are possibly composed of CdO or CdSO₄, as there is a corresponding increase in the Oxygen content of the films after annealing.

In addition the CCI images show evidence that the CdS thin films grown at higher deposition temperatures have increasingly irregular film surfaces. Such features include incomplete substrate coverage, and a large quantity of particulate adhered to the films surface, as seen in Figures 5-4-35, and 5-4-39. A smooth consistent film surface is obtainable from CdS thin films that are as-deposited and grown at lower temperatures, as seen in Figure 5-4-7. The AFM analysis agrees with the CCI analysis in that low temperature grown films have a smoother surface than those that grown at higher temperatures. This can be illustrated by comparing the low temperature grown film in Figures 5-5-3 and 5-5-4 with the high temperature grown films in Figures 5-5-23 and 5-5-24. The AFM analysis also indicates that the as-deposited films generally have smoother surface topography than the corresponding annealed films. This can be seen by making a comparison of Figures 5-5-31, 5-5-32 and Figures 5-5-35, 5-5-36. This could be due to the decreased frequency of the ion by ion deposition of CdS onto the substrate, and the increased frequency of the formation of colloidal particulates in solution that then adhere to the surface of the substrate disrupting the uniform growth of the film at increased deposition temperatures.
The PIXE analysis indicates that there is an increasing Sulfur deficiency in the CdS thin films grown at lower temperatures. Therefore, the Cadmium to Sulfur ratio is decreasing with increasing deposition temperature. This could be the result of more Sulfur ions being released from dissolved compounds ready for deposition at increased temperatures.

An analysis of the effects of illumination on the resistance of the CdS thin films has revealed that the as-deposited films have a lower resistance than those annealed in air. This data is inconsistent with that present in the current literature. The as deposited films should be more resistive than the annealed films. This may be due to problems with contacting the samples with the analysis circuit and the extremely thin films causing short circuit effects, rendering the data anomalous.
CONCLUSIONS

- Annealing of the CdS thin films in an air atmosphere increases the Oxygen content of the films constituents.
- Annealed CdS thin films also appear to have a slightly higher Indium dopant concentration.
- The dopant concentration in the CBD solution is proportional to the dopant concentration in the CdS thin film after deposition.
- The Indium dopant concentration is not constant with the depth of the CdS thin film and decreases with increasing thickness.
- The annealing of the CdS thin films develops nodule like structures at the surface of the film.
- The annealing process also decreases the smooth surface characteristic found in the as-deposited CdS thin film surfaces.
- CdS thin films grown at higher temperatures were shown to have more irregular surface features, in that incomplete coverage of the substrate was experienced as well as an increase in the amount of particulate adhered to the films surface.
- CdS thin films grown at lower deposition temperatures also had increased sulfur deficiencies.
- For future studies it is recommended that the nodule like structures present on the surfaces of the annealed CdS thin films be quantitatively examined to determine their composition relative to the rest of the film.

End
APPENDIX A: Materials Safety Data Sheets

Product Number: 289159
Product Name: Cadmium acetate, dihydrate, 98%

Valid 05/2002 - 07/2002

Sigma Aldrich Pty., Ltd.
2/14 Ancilla Avenue
Castle Hill NSW 2154 Australia
Phone: 61 2 9841 0555
Fax: 61 2 9841 0500
Email: ausmail@sial.com

MATERIAL SAFETY DATA SHEET

SECTION 1. --------- CHEMICAL IDENTIFICATION ---------
CATALOG #: 289159
NAME: CADMIUM ACETATE DIHYDRATE, 98%

SECTION 2. ----- COMPOSITION/INFORMATION ON INGREDIENTS -----­
CAS #: 5743-04-4
MF: C2H4O2
SYNONYMS
CADMIUM ACETATE DIHYDRATE *
CADMIUM DIACETATE DIHYDRATE *

SECTION 3. --------- HAZARDS IDENTIFICATION ---------
LABEL PRECAUTIONARY STATEMENTS
TOXIC
MAY CAUSE CANCER.
HARMFUL BY INHALATION, IN CONTACT WITH SKIN AND IF SWALLOWED.
DANGER:
CONTAINS CADMIUM.
CANCER HAZARD.
AVOID CREATING DUST.
CAN CAUSE LUNG AND KIDNEY DISEASE.
IN CASE OF ACCIDENT OR IF YOU FEEL UNWELL, SEEK MEDICAL ADVICE IMMEDIATELY (SHOW THE LABEL WHERE POSSIBLE).
WEAR SUITABLE PROTECTIVE CLOTHING, GLOVES AND EYE/FACE PROTECTION.

SECTION 4. --------- FIRST-AID MEASURES ---------
IN CASE OF CONTACT, IMMEDIATELY FLUSH EYES OR SKIN WITH COPIOUS AMOUNTS OF WATER FOR AT LEAST 15 MINUTES WHILE REMOVING CONTAMINATED CLOTHING AND SHOES.
IF INHALED, REMOVE TO FRESH AIR. IF NOT BREATHING GIVE ARTIFICIAL RESPIRATION. IF BREATHING IS DIFFICULT, GIVE OXYGEN.
IF SWALLOWED, WASH OUT MOUTH WITH WATER PROVIDED PERSON IS CONSCIOUS.
CALL A PHYSICIAN.
DISCARD CONTAMINATED CLOTHING AND SHOES.

SECTION 5. --------- FIRE FIGHTING MEASURES ---------
EXTINGUISHING MEDIA
WATER SPRAY.
CARBON DIOXIDE, DRY CHEMICAL POWDER OR APPROPRIATE FOAM.
SPECIAL FIREFIGHTING PROCEDURES
WEAR SELF-CONTAINED BREATHING APPARATUS AND PROTECTIVE CLOTHING TO PREVENT CONTACT WITH SKIN AND EYES.
UNUSUAL FIRE AND EXPLOSIONS HAZARDS
EMITS TOXIC FUMES UNDER FIRE CONDITIONS.
SECTION 6.  ACCIDENTAL RELEASE MEASURES

EVACUATE AREA.
WEAR SELF-CONTAINED BREATHING APPARATUS, RUBBER BOOTS AND HEAVY RUBBER GLOVES.
WEAR DISPOSABLE COVERALLS AND DISCARD THEM AFTER USE.
SWEEP UP, PLACE IN A BAG AND HOLD FOR WASTE DISPOSAL.
VENTILATE AREA AND WASH SPILL SITE AFTER MATERIAL PICKUP IS COMPLETE.

SECTION 7.  HANDLING AND STORAGE

REFER TO SECTION 8.

SECTION 8.  EXPOSURE CONTROLS/PERSONAL PROTECTION

WEAR APPROPRIATE NIOSH/MSHA-APPROVED RESPIRATOR, CHEMICAL-RESISTANT GLOVES, SAFETY GOGGLES, OTHER PROTECTIVE CLOTHING.
SAFETY SHOWER AND EYE BATH.
USE ONLY IN A CHEMICAL FUME HOOD.
DO NOT BREATHE DUST.
AVERSE ALL CONTACT.
WASH THOROUGHLY AFTER HANDLING.
CARCINOGEN.
HARMFUL SOLID.
KEEP TIGHTLY CLOSED.
STORE IN A COOL DRY PLACE.

SECTION 9.  PHYSICAL AND CHEMICAL PROPERTIES

APPEARANCE AND ODOR
WHITE CRYSTALLINE POWDER

SECTION 10.  STABILITY AND REACTIVITY

INCOMPATIBILITIES
STRONG OXIDIZING AGENTS
STRONG ACIDS
STRONG BASES
HAZARDOUS COMBUSTION OR DECOMPOSITION PRODUCTS
TOXIC FUMES OF:
CARBON MONOXIDE, CARBON DIOXIDE

SECTION 11.  TOXICOLOGICAL INFORMATION

ACUTE EFFECTS
HARMFUL IF SWALLOWED, INHALED, OR ABSORBED THROUGH SKIN.
MAY CAUSE IRRITATION.

CHRONIC EFFECTS
CARCINOGEN.
TARGET ORGAN(S): LUNGS, KIDNEYS
TO THE BEST OF OUR KNOWLEDGE, THE CHEMICAL, PHYSICAL, AND TOXICOLOGICAL PROPERTIES HAVE NOT BEEN THOROUGHLY INVESTIGATED.

RTECS #: AF7505000
ACETIC ACID, CADMIUM SALT, DIHYDRATE
TOXICITY DATA
ORL-RAT LD50: 360 MG/KG
KHZDAN 22, 168, 1979
ONLY SELECTED REGISTRY OF TOXIC EFFECTS OF CHEMICAL SUBSTANCES (RTECS) DATA IS PRESENTED HERE. SEE ACTUAL ENTRY IN RTECS FOR COMPLETE INFORMATION.

SECTION 12.  ECOLOGICAL INFORMATION

DATA NOT YET AVAILABLE.

SECTION 13.  DISPOSAL CONSIDERATIONS

CONTACT A LICENSED PROFESSIONAL WASTE DISPOSAL SERVICE TO DISPOSE OF THIS MATERIAL.
OBSERVE ALL FEDERAL, STATE AND LOCAL ENVIRONMENTAL REGULATIONS.

SECTION 14.  TRANSPORT INFORMATION

CONTACT ALDRICH CHEMICAL COMPANY FOR TRANSPORTATION INFORMATION.

SECTION 15.  REGULATORY INFORMATION

EUROPEAN INFORMATION
CAUTION: SUBSTANCE NOT YET FULLY TESTED.

TOXIC

R 45

MAY CAUSE CANCER.

R 20/21/22

HARMFUL BY INHALATION, IN CONTACT WITH SKIN AND IF SWALLOWED.

S 45

IN CASE OF ACCIDENT OR IF YOU FEEL UNWELL, SEEK MEDICAL ADVICE IMMEDIATELY (SHOW THE LABEL WHERE POSSIBLE).

S 36/37/39

WEAR SUITABLE PROTECTIVE CLOTHING, GLOVES AND EYE/FACE PROTECTION.

REVIEWS, STANDARDS, AND REGULATIONS

OEL = MAK

ACGIH TLV-TWA 0.01 MG(CD)/M3, INHALABLE DUST* TLV/BEI, 1999
ACGIH TLV-TWA 0.002 MG(CD)/M3, RESPIRABLE DUST* TLV/BEI, 1999
ACGIH TLV-SUSPECTED HUMAN CARCINOGEN* TLV/BEI, 1999
IARC CANCER REVIEW: HUMAN SUFFICIENT EVIDENCE IMEMDT 58, 119, 1993
IARC CANCER REVIEW: ANIMAL SUFFICIENT EVIDENCE IMEMDT 58, 119, 1993
IARC CANCER REVIEW: GROUP I IMEMDT 58, 119, 1993

MSHA STANDARD AIR: TWA 0.2 MG(CD)/M3

TLV'S* 3, 34, 1971

OEL-ARAB REPUBLIC OF EGYPT: TWA 0.05 MG(CD)/M3, JAN1993
OEL-AUSTRALIA: TWA 0.05 MG(CD)/M3, JAN1993
OEL-AUSTRIA: CARCINOGEN, JAN1999
OEL-BELGIUM: TWA 0.05 MG(CD)/M3, JAN1993
OEL-DENMARK: TWA 0.01 MG(CD)/M3, JAN1999
OEL-FINLAND: TWA 0.02 MG(CD)/M3, CARCINOGEN, JAN1999
OEL-FRANCE: VME 0.05 MG(CD)/M3, JAN1999
OEL-GERMANY: CARCINOGEN, JAN1999
OEL-INDIA: TWA 0.05 MG(CD)/M3, JAN1993
OEL-JAPAN: OEL 0.05 MG(CD)/M3, GROUP 1 CARCINOGEN, JAN1999
OEL-NORWAY: TWA 0.05 MG(CD)/M3, JAN1999
OEL-THE PHILIPPINES: TWA 0.2 MG(CD)/M3, JAN1993
OEL-POLAND: MAC(TWA) FUME 0.02 MG(CD)/M3, MAC(STEL) FUME 0.05 MG(CD)/M3, JAN1999
OEL-POLAND: MAC(TWA) DUST 0.04 MG(CD)/M3, MAC(STEL) DUST 0.2 MG(CD)/M3, JAN1999
OEL-RUSSIA: TWA 0.01 MG(CD)/M3, STEL 0.05 MG(CD)/M3, JAN1993
OEL-SWEDEN: NGV 0.02 MG(CD)/M3, CARCINOGEN, JAN1999
OEL-SWITZERLAND: MAK-W 0.05 MG(CD)/M3, CARCINOGEN, JAN1999
OEL-THAILAND: TWA 0.2 MG(CD)/M3, STEL 0.5 MG(CD)/M3, JAN1993
OEL-TURKEY: TWA 0.2 MG(CD)/M3, JAN1993
OEL-UNITED KINGDOM: TWA 0.025 MG(CD)/M3, SEP2000
OEL IN ARGENTINA, BULGARIA, COLOMBIA, JORDAN, KOREA CHECK ACGIH TLV;
OEL IN NEW ZEALAND, SINGAPORE, VIETNAM CHECK ACGIH TLV

U.S. INFORMATION

THIS PRODUCT IS SUBJECT TO SARA SECTION 313 REPORTING REQUIREMENTS.

SECTION 16. OTHER INFORMATION-

THE ABOVE INFORMATION IS BELIEVED TO BE CORRECT BUT DOES NOT PURPORT TO BE ALL INCLUSIVE AND SHALL BE USED ONLY AS A GUIDE. SIGMA, ALDRICH, FLUKA SHALL NOT BE HELD LIABLE FOR ANY DAMAGE RESULTING FROM HANDLING OR FROM CONTACT WITH THE ABOVE PRODUCT. SEE REVERSE SIDE OF INVOICE OR PACKING SLIP FOR ADDITIONAL TERMS AND CONDITIONS OF SALE.

COPYRIGHT 2001 SIGMA-ALDRICH CO.

LICENSE GRANTED TO MAKE UNLIMITED PAPER COPIES FOR INTERNAL USE ONLY

Product Number: T33553

Product Name: Thiourea, 99%
MATERIAL SAFETY DATA SHEET

SECTION 1. CHEMICAL IDENTIFICATION
CATALOG #: T33553
NAME: THIOUREA, 99%

SECTION 2. COMPOSITION/INFORMATION ON INGREDIENTS
CAS #: 62-56-6
MF: CH4N2S
EC NO: 200-543-5
SYNONYMS
ISOThIOUREA * PSEUDOTHIOUREA * RCRA WASTE NUMBER U219 * SULOUREA *
THIOCARBAMIDE * THIOCARBONIC ACID DIAMIDE * THIOMOCOVINA (CZECH) *
BETA-THIOPSEUDOUREA * 2-THIOPSEUDOUREA * THIOUREA * 2-THIOUREA * THU *
TSIZP 34 * UREA, THIO- (SCI) * USAF EK-497 *

SECTION 3. HAZARDS IDENTIFICATION
LABEL PRECAUTIONARY STATEMENTS
TOXIC
DANGEROUS FOR THE ENVIRONMENT
TOXIC IF SWALLOWED.
POSSIBLE RISK OF IRREVERSIBLE EFFECTS.
IRRITATING TO SKIN.
MAY CAUSE SENSITIZATION BY SKIN CONTACT.
TOXIC TO AQUATIC ORGANISMS, MAY CAUSE LONG-TERM ADVERSE EFFECTS IN THE AQUATIC ENVIRONMENT.
POSSIBLE CARCINOGEN (US)
TARGET ORGAN(S):
LIVER
THYROID
CALIF. PROP. 65 CARCINOGEN.
IN CASE OF CONTACT WITH EYES, RINSE IMMEDIATELY WITH PLENTY OF WATER AND SEEK MEDICAL ADVICE.
WEAR SUITABLE PROTECTIVE CLOTHING AND GLOVES.
AVOID RELEASE TO THE ENVIRONMENT. REFER TO SPECIAL INSTRUCTIONS/SAFETY DATA SHEETS.

SECTION 4. FIRST-AID MEASURES
IF SWALLOWED, WASH OUT MOUTH WITH WATER PROVIDED PERSON IS CONSCIOUS.
CALL A PHYSICIAN IMMEDIATELY.
IF INHALED, REMOVE TO FRESH AIR. IF NOT BREATHING GIVE ARTIFICIAL RESPIRATION. IF BREATHING IS DIFFICULT, GIVE OXYGEN.
IN CASE OF SKIN CONTACT, FLUSH WITH COPIOUS AMOUNTS OF WATER FOR AT LEAST 15 MINUTES. REMOVE CONTAMINATED CLOTHING AND SHOES. CALL A PHYSICIAN.
IN CASE OF CONTACT WITH EYES, FLUSH WITH COPIOUS AMOUNTS OF WATER FOR AT LEAST 15 MINUTES. ASSURE ADEQUATE FLUSHING BY SEPARATING THE EYELIDS WITH FINGERS. CALL A PHYSICIAN.

SECTION 5. FIRE FIGHTING MEASURES
EXTINGUISHING MEDIA
WATER SPRAY.
CARBON DIOXIDE, DRY CHEMICAL POWDER OR APPROPRIATE FOAM.  
SPECIAL FIREFIGHTING PROCEDURES  
WEAR SELF-CONTAINED BREATHING APPARATUS AND PROTECTIVE CLOTHING TO PREVENT CONTACT WITH SKIN AND EYES. 
UNUSUAL FIRE AND EXPLOSIONS HAZARDS  
EMITS TOXIC FUMES UNDER FIRE CONDITIONS.  
SECTION 6. - - - - - - ACCIDENTAL RELEASE MEASURES - - - - - -  
WEAR SELF-CONTAINED BREATHING APPARATUS, RUBBER BOOTS AND HEAVY RUBBER GLOVES.  
Sweep up, place in a bag and hold for waste disposal. 
Avoid raising dust.  
Ventilate area and wash spill site after material pickup is complete.  
Evacuate area.  
SECTION 7. - - - - - - HANDLING AND STORAGE - - - - - -  
Refer to Section 8.  
SECTION 8. - - - - EXPOSURE CONTROLS/PERSONAL PROTECTION - - - -  
Use only in a chemical fume hood.  
Safety shower and eye bath.  
Wash contaminated clothing before reuse.  
Wash thoroughly after handling.  
Do not breathe dust.  
Do not get in eyes, on skin, on clothing.  
Avoid prolonged or repeated exposure.  
NIOSH/MSHA-APPROVED RESPIRATOR.  
COMPATIBLE CHEMICAL-RESISTANT GLOVES.  
CHEMICAL SAFETY GOGGLES.  
Keep tightly closed.  
Store in a cool dry place.  
SECTION 9. - - - - PHYSICAL AND CHEMICAL PROPERTIES - - - - - -  
PHYSICAL PROPERTIES  
MELTING POINT:  174 - 177 C  
SECTION 10. - - - - - - STABILITY AND REACTIVITY - - - - - -  
STABILITY  
STABLE.  
INCOMPATIBILITIES  
HEAT  
STRONG OXIDIZING AGENTS  
STRONG ACIDS  
STRONG BASES  
HAZARDOUS COMBUSTION OR DECOMPOSITION PRODUCTS  
CARBON MONOXIDE, CARBON DIOXIDE  
NITROGEN OXIDES  
SULFUR OXIDES  
HAZARDOUS POLYMERIZATION  
WILL NOT OCCUR.  
SECTION 11. - - - - - - TOXICOLOGICAL INFORMATION - - - - - -  
ACUTE EFFECTS  
CAUSES SKIN IRRITATION.  
MAY BE HARMFUL IF ABSORBED THROUGH THE SKIN.  
MAY CAUSE EYE IRRITATION.  
MAY BE HARMFUL IF INHALED.  
MATERIAL MAY BE IRRITATING TO MUCOUS MEMBRANES AND UPPER RESPIRATORY TRACT.  
TOXIC IF SWALLOWED.  
MAY CAUSE ALLERGIC SKIN REACTION.  
CHRONIC EFFECTS  
THIS PRODUCT IS OR CONTAINS A COMPONENT THAT HAS BEEN REPORTED TO BE POSSIBLY CARCINOGENIC BASED ON ITS IARC, ACGIH, NTP OR EPA CLASSIFICATION.  
TARGET ORGAN(S):
LIVER
THYROID
BONE MARROW
POSSIBLE RISK OF CONGENITAL MALFORMATION IN THE FETUS.
RTECS #: YU2800000
UREA, 2-THIO-
IRRITATION DATA
EYE-RBT 14%

TOXICITY DATA
UNR-MAN LD50:147 MG/KG
ORL-RAT LD50:125 MG/KG
IPR-RAT LD50:436 MG/KG
IPR-MUS LD50:100 MG/KG
IPR-MAM LD50:3500 MG/KG

GTPZAB 30(3),42,1986
85DCAI 2,73,1970
HBTXAC 5,177,1959
FCTXAV 3,597,1965
NTIS** AD277-689

TARGET ORGAN DATA
LUNGS, THORAX OR RESPIRATION (OTHER CHANGES)
LIVER (MULTIPLE EFFECTS)
BLOOD (HEMORRHAGE)
BLOOD (GRANULOCYTOPENIA)
BLOOD (CHANGES IN CELL COUNT)
EFFECTS ON FERTILITY (POST-IMPLANTATION MORTALITY)
SPECIFIC DEVELOPMENTAL ABNORMALITIES (CENTRAL NERVOUS SYSTEM)
SPECIFIC DEVELOPMENTAL ABNORMALITIES (MUSCULOSKELETAL SYSTEM)
SPECIFIC DEVELOPMENTAL ABNORMALITIES (ENDOCRINE SYSTEM)
TUMORIGENIC (EQUIVOCAL TUMORIGENIC AGENT BY RTECS CRITERIA)

ADDITIONAL INFORMATION
ORL-RAT LD50:1750 MG/KG
SKN-RBT LD50>2800 MG/KG

ONLY SELECTED REGISTRY OF TOXIC EFFECTS OF CHEMICAL SUBSTANCES
(RTECS) DATA IS PRESENTED HERE. SEE ACTUAL ENTRY IN RTECS FOR
COMPLETE INFORMATION.

SECTION 12. - - - - - - - - ECOLOGICAL INFORMATION - - - - - - -
DATA NOT YET AVAILABLE.

SECTION 13. - - - - - - DISPOSAL CONSIDERATIONS - - - - - - - -
CONTACT A LICENSED PROFESSIONAL WASTE DISPOSAL SERVICE TO DISPOSE OF
THIS MATERIAL.
DISSOLVE OR MIX THE MATERIAL WITH A COMBUSTIBLE SOLVENT AND BURN IN A
CHEMICAL INCINERATOR EQUIPPED WITH AN AFTERBURNER AND SCRUBBER.
OBSERVE ALL FEDERAL, STATE AND LOCAL ENVIRONMENTAL REGULATIONS.

SECTION 14. - - - - - - TRANSPORT INFORMATION - - - - - - - -
CONTACT ALDRICH CHEMICAL COMPANY FOR TRANSPORTATION INFORMATION.

SECTION 15. - - - - - - REGULATORY INFORMATION - - - - - - - -
EUROPEAN INFORMATION
EC INDEX NO: 612-082-00-0
TOXIC
DANGEROUS FOR THE ENVIRONMENT
R 22
HARMFUL IF SWALLOWED.
R 40
POSSIBLE RISK OF IRREVERSIBLE EFFECTS.
R 51/53
TOXIC TO AQUATIC ORGANISMS, MAY CAUSE LONG-TERM ADVERSE EFFECTS
IN THE AQUATIC ENVIRONMENT.
R 63
POSSIBLE RISK OF HARM TO THE UNBORN CHILD.
S 36/37
WEAR SUITABLE PROTECTIVE CLOTHING AND GLOVES.
S 61
AVOID RELEASE TO THE ENVIRONMENT. REFER TO SPECIAL INSTRUCTIONS/
SAFETY DATA SHEETS.
REVIEWS, STANDARDS, AND REGULATIONS
OEL=MAK
IARC CANCER REVIEW: ANIMAL SUFFICIENT EVIDENCE IMEMDT 7,95,1974
IARC CANCER REVIEW: HUMAN NO ADEQUATE DATA IMEMDT 7,95,1974
IARC CANCER REVIEW: GROUP 2B IMEMDL 7,56,1987
OEL-AUSTRIA: SUSPECTED CARCINOCEN, JAN1999
OEL-FINLAND: CARCINOCEN, JAN1999
OEL-FRANCE: CARCINOCEN, JAN1993
OEL-GERMANY: CARCINOCEN, JAN1999
OEL-RUSSIA: STEL 0.3 MG/M3, JAN1993
OEL-SWEDEN: CARCINOCEN, JAN1999
NOHS 1974: HZD 82272; NIS 29; TNF 1179; NOS 25; TNE 12517
NOES 1983: HZD 82272; NIS 50; TNF 2999; NOS 57; TNE 37571; TFE 10969
EPA GENETOX PROGRAM 1988, POSITIVE: CARCINOGENICITY-MOUSE/RAT; CELL TRANSFORM.-SA7/F344 RAT
EPA GENETOX PROGRAM 1988, POSITIVE: SHE-CLONAL ASSAY; CELL TRANSFORM.-RLY F344 RAT EMBRYO
EPA GENETOX PROGRAM 1988, POSITIVE: HOST-MEDIATED ASSAY
EPA GENETOX PROGRAM 1988, NEGATIVE: CELL TRANSFORM.-SA7/SHE; E COLI POLA WITH S9
EPA GENETOX PROGRAM 1988, NEGATIVE: HISTIDINE REVERSION-AMES TEST; SPERM MORPHOLOGY-MOUSE
EPA GENETOX PROGRAM 1988, NEGATIVE: S CEREVISIAE-HOMOZYGOsis
EPA GENETOX PROGRAM 1988, INCONCLUSIVE: E COLI POLA WITHOUT S9
EPA TSCA SECTION 8(8) CHEMICAL INVENTORY
EPA TSCA TEST SUBMISSION (TSCATS) DATA BASE, JANUARY 2001
NTP 8TH REPORT ON CARCINOGENS, 2000: REASONABLY ANTICIPATED TO BE HUMAN CARCINOGEN
U.S. INFORMATION
THIS PRODUCT IS SUBJECT TO SARA SECTION 313 REPORTING REQUIREMENTS.
CALIFORNIA PROPOSITION 65:
THIS PRODUCT IS OR CONTAINS CHEMICAL(S) KNOWN TO THE STATE OF CALIFORNIA TO CAUSE CANCER.
SECTION 16. OTHER INFORMATION
THE ABOVE INFORMATION IS BELIEVED TO BE CORRECT BUT DOES NOT PURPORT TO BE ALL INCLUSIVE AND SHALL BE USED ONLY AS A GUIDE. SIGMA, ALDRICH, FLUKA SHALL NOT BE HELD LIABLE FOR ANY DAMAGE RESULTING FROM HANDLING OR FROM CONTACT WITH THE ABOVE PRODUCT. SEE REVERSE SIDE OF INVOICE OR PACKING SLIP FOR ADDITIONAL TERMS AND CONDITIONS OF SALE.
COPYRIGHT 2001 SIGMA-ALDRICH CO.
LICENSE GRANTED TO MAKE UNLIMITED PAPER COPIES FOR INTERNAL USE ONLY

Product Number: 334073
Product Name: Indium(III) chloride, tetrahydrate, 97%
Valid 05/2002 - 07/2002

 Sigma Aldrich Pty., Ltd.
 2/14 Antella Avenue
  Castle Hill NSW 2154 Australia
  Phone: 61 2 9841 0555
  Fax: 61 2 9841 0500
  Email: ausmail@sial.com

MATERIAL SAFETY DATA SHEET

SECTION 1. CHEMICAL IDENTIFICATION

95
CATALOG #: 334073
NAME: INDIUM(III) CHLORIDE TETRAHYDRATE, 97%

SECTION 2. ----- COMPOSITION/INFORMATION ON INGREDIENTS ----- 
CAS #: 22519-64-8
MF: CL3IN
SYNONYMS
INDIUM TRICHLORIDE TETRAHYDRATE *

SECTION 3. ----------- HAZARDS IDENTIFICATION -----------
LABEL PRECAUTIONARY STATEMENTS
HIGHLY TOXIC (USA)
TOXIC (EU)
TOXIC BY INHALATION, IN CONTACT WITH SKIN AND IF SWALLOWED.
CAUSES BURNS.
IN CASE OF ACCIDENT OR IF YOU FEEL UNWELL, SEEK MEDICAL ADVICE
IMMEDIATELY (SHOW THE LABEL WHERE POSSIBLE).
IN CASE OF CONTACT WITH EYES, RINSE IMMEDIATELY WITH PLENTY OF
WATER AND SEEK MEDICAL ADVICE.
DO NOT BREATHE DUST.
WEAR SUITABLE PROTECTIVE CLOTHING, GLOVES AND EYE/FACE
PROTECTION.
MOISTURE SENSITIVE
KEEP TIGHTLY CLOSED.

SECTION 4. --------- FIRST-AID MEASURES----------
IN CASE OF CONTACT, IMMEDIATELY FLUSH EYES OR SKIN WITH COPIOUS
AMOUNTS OF WATER FOR AT LEAST 15 MINUTES WHILE REMOVING CONTAMINATED
CLOTHING AND SHOES.
IF INHALED, REMOVE TO FRESH AIR. IF NOT BREATHING GIVE ARTIFICIAL
RESPIRATION. IF BREATHING IS DIFFICULT, GIVE OXYGEN.
IF SWALLOWED, WASH OUT MOUTH WITH WATER PROVIDED PERSON IS CONSCIOUS.
CALL A PHYSICIAN IMMEDIATELY.
WASH CONTAMINATED CLOTHING BEFORE REUSE.

SECTION 5. --------- FIRE FIGHTING MEASURES ---------
EXTINGUISHING MEDIA
NONCOMBUSTIBLE.
USE EXTINGUISHING MEDIA APPROPRIATE TO SURROUNDING FIRE CONDITIONS.
SPECIAL FIREFIGHTING PROCEDURES
WEAR SELF-CONTAINED BREATHING APPARATUS AND PROTECTIVE CLOTHING TO
PREVENT CONTACT WITH SKIN AND EYES.
UNUSUAL FIRE AND EXPLOSIONS HAZARDS
EMITS TOXIC FUMES UNDER FIRE CONDITIONS.

SECTION 6. --------- ACCIDENTAL RELEASE MEASURES---------
EVACUATE AREA.
WEAR SELF-CONTAINED BREATHING APPARATUS, RUBBER BOOTS AND HEAVY
RUBBER GLOVES.
SWEEP UP, PLACE IN A BAG AND HOLD FOR WASTE DISPOSAL.
AVOID RAISING DUST.
VENTILATE AREA AND WASH SPILL SITE AFTER MATERIAL PICKUP IS COMPLETE.

SECTION 7. --------- HANDLING AND STORAGE------------
REFER TO SECTION 8.

SECTION 8. --------- EXPOSURE CONTROLS/PERSONAL PROTECTION------
WEAR APPROPRIATE NIOSH/MSHA-APPROVED RESPIRATOR, CHEMICAL-RESISTANT
GLOVES, SAFETY GOGGLES, OTHER PROTECTIVE CLOTHING.
SAFETY SHOWER AND EYE BATH.
USE ONLY IN A CHEMICAL FUME HOOD.
DO NOT BREATHE DUST.
AVOID CONTACT WITH EYES, SKIN AND CLOTHING.
AVOID PROLONGED OR REPEATED EXPOSURE.
WASH THOROUGHLY AFTER HANDLING.
HIGHLY TOXIC.
CORROSIVE.
KEEP TIGHTLY CLOSED.
MOISTURE SENSITIVE
STORE IN A COOL DRY PLACE.

SECTION 9. -- PHYSICAL AND CHEMICAL PROPERTIES --

APPEARANCE AND ODOR
WHITE TO OFF-WHITE CRYSTALLINE CHUNKS

SECTION 10. -- STABILITY AND REACTIVITY --

INCOMPATIBILITIES
STRONG ACIDS
MAY DECOMPOSE ON EXPOSURE TO MOIST AIR OR WATER.
HAZARDOUS COMBUSTION OR DECOMPOSITION PRODUCTS
HYDROGEN CHLORIDE GAS

SECTION 11. -- TOXICOLOGICAL INFORMATION --

ACUTE EFFECTS
MAY BE FATAL IF INHALED, SWALLOWED, OR ABSORBED THROUGH SKIN.
MATERIAL IS EXTREMELY DESTRUCTIVE TO TISSUE OF THE MUCOUS MEMBRANES
AND UPPER RESPIRATORY TRACT, EYES AND SKIN.
INHALATION MAY RESULT IN SPASM, INFLAMMATION AND EDEMA OF THE
LARYNX AND BRONCHI, CHEMICAL PNEUMONITIS AND PULMONARY EDEMA.
SYMPTOMS OF EXPOSURE MAY INCLUDE BURNING SENSATION, COUGHING,
WHEEZING, LARYNGITIS, SHORTNESS OF BREATH, HEADACHE, NAUSEA AND
VOMITING.

TO THE BEST OF OUR KNOWLEDGE, THE CHEMICAL, PHYSICAL, AND
TOXICOLOGICAL PROPERTIES HAVE NOT BEEN THOROUGHLY INVESTIGATED.

RTECS #: NL1430000
INDIUM CHLORIDE, TETRAHYDRATE

TOXICITY DATA
NPR-MUS LD50: 12 MG/KG
IPR-MUS LD50: 12 MG/KG

ADDITIONAL INFORMATION
ACGIH TLV-TWA: 0.1 MG/M3, INDIUM COMPOUNDS AS INDIUM. OSHA PEL: 8H
TWA 0.1 MG/M3, INDIUM COMPOUNDS.

ONLY SELECTED REGISTRY OF TOXIC EFFECTS OF CHEMICAL SUBSTANCES
(RTECS) DATA IS PRESENTED HERE. SEE ACTUAL ENTRY IN RTECS FOR
COMPLETE INFORMATION.

SECTION 12. -- ECOLOGICAL INFORMATION --
DATA NOT YET AVAILABLE.

SECTION 13. -- DISPOSAL CONSIDERATIONS --
THE MATERIAL SHOULD BE DISSOLVED IN 1) WATER; 2) ACID SOLUTION OR 3)
OXIDIZED TO A WATER-SOLUBLE STATE. PRECIPITATE THE MATERIAL AS THE
SULFIDE, ADJUSTING THE pH OF THE SOLUTION TO 7 TO COMPLETE PRE-
CIPITATION. FILTER THE INSOLUBLES AND DISPOSE OF THEM IN A HAZARDOUS-
WASTE SITE. DESTROY ANY EXCESS SULFIDE WITH SODIUM HYPOCHLORITE.
NEUTRALIZE THE SOLUTION BEFORE FLUSHING DOWN THE DRAIN.

OBSERVE ALL FEDERAL, STATE AND LOCAL ENVIRONMENTAL REGULATIONS.

SECTION 14. -- TRANSPORT INFORMATION

CONTACT ALDRICH CHEMICAL COMPANY FOR TRANSPORTATION INFORMATION.

SECTION 15. -- REGULATORY INFORMATION

EUROPEAN INFORMATION
CAUTION: SUBSTANCE NOT YET FULLY TESTED.

TOXIC
R 23/24/25
TOXIC BY INHALATION, IN CONTACT WITH SKIN AND IF SWALLOWED.
R 34
CAUSES BURNS.
S 45
IN CASE OF ACCIDENT OR IF YOU FEEL UNWELL, SEEK MEDICAL ADVICE
IMMEDIATELY (SHOW THE LABEL WHERE POSSIBLE).
S 26
IN CASE OF CONTACT WITH EYES, RINSE IMMEDIATELY WITH PLENTY OF
WATER AND SEEK MEDICAL ADVICE.
Section 1. Chemical Identification

Catalog #: 208183
Name: Cadmium sulfide

Section 2. Composition/Information on Ingredients

CAS #: 1306-23-6
MF: CDS
EC No: 215-147-8

Synonyms
Cadmium Golden 366 * Cadmium Lemon Yellow 527 * Cadmium Monosulfide * Cadmium Orange * Cadmium Primrose 819 * Cadmium Sulphide * Cadmium Yellow * Cadmium Yellow 000 * Cadmium Yellow 892 * Cadmium Yellow Conc. Deep * Cadmium Yellow Conc. Golden * Cadmium Yellow Conc. Lemon * Cadmium Yellow Conc. Primrose * Cadmium Yellow 10G Conc. * Cadmium Yellow OZ Dark * Cadmium Yellow Primrose 47-4100 * Cadmopur Golden Yellow N * Cadmopur Yellow * Capsebon * C.P. Golden Yellow 55 * Ferro Lemon Yellow * Ferro Orange Lemon * Ferro Yellow * Greenockite * GSK * NCI-CD271 * PC 108 * Primrose 1466 *

Section 3. Hazards Identification

Label Precautionary Statements
Toxic
MAY CAUSE CANCER.
Harmful by Inhalation, in Contact with Skin and If Swallowed.
Danger:
Cancer Hazard.
Can Cause Lung and Kidney Disease.
In Case of Accident or If You Feel Unwell, Seek Medical Advice

Copyright 2001 Sigma-Aldrich Co.
License Granted to Make Unlimited Paper Copies for Internal Use Only
IMMEDIATELY (SHOW THE LABEL WHERE POSSIBLE).
IN CASE OF CONTACT WITH EYES, RINSE IMMEDIATELY WITH PLENTY OF
WATER AND SEEK MEDICAL ADVICE.
WEAR SUITABLE PROTECTIVE CLOTHING, GLOVES AND EYE/FACE
PROTECTION.
SECTION 4. FIRST-AID MEASURES
IN CASE OF CONTACT, IMMEDIATELY FLUSH EYES OR SKIN WITH COPIOUS
AMOUNTS OF WATER FOR AT LEAST 15 MINUTES WHILE REMOVING CONTAMINATED
CLOTHING AND SHOES.
IF INHALED, REMOVE TO FRESH AIR. IF NOT BREATHING GIVE ARTIFICIAL
RESPIRATION. IF BREATHING IS DIFFICULT, GIVE OXYGEN.

SECTION 5. FIRE FIGHTING MEASURES
EXTINGUISHING MEDIA
NONCOMBUSTIBLE.
USE EXTINGUISHING MEDIA APPROPRIATE TO SURROUNDING FIRE CONDITIONS.
SPECIAL FIREFIGHTING PROCEDURES
WEAR SELF-CONTAINED BREATHING APPARATUS AND PROTECTIVE CLOTHING TO
PREVENT CONTACT WITH SKIN AND EYES.
UNUSUAL FIRE AND EXPLOSIONS HAZARDS
EMITS TOXIC FUMES UNDER FIRE CONDITIONS.

SECTION 6. ACCIDENTAL RELEASE MEASURES
EVACUATE AREA.
WEAR SELF-CONTAINED BREATHING APPARATUS, RUBBER BOOTS AND HEAVY
RUBBER GLOVES.
WEAR DISPOSABLE COVERALLS AND DISCARD THEM AFTER USE.
SWEEP UP, PLACE IN A BAG AND HOLD FOR WASTE DISPOSAL.
AVOID RAISING DUST.

SECTION 7. HANDLING AND STORAGE
REFER TO SECTION 8.

SECTION 8. EXPOSURE CONTROLS/PERSONAL PROTECTION
WEAR APPROPRIATE NIOSH/MSHA-APPROVED RESPIRATOR, CHEMICAL-RESISTANT
GLOVES, SAFETY GOGGLES, OTHER PROTECTIVE CLOTHING.
USE ONLY IN A CHEMICAL FUME HOOD.
SAFETY SHOWER AND EYE BATH.
DO NOT BREATHE DUST.
DO NOT GET IN EYES, ON SKIN, ON CLOTHING.
AVOID PROLONGED OR REPEATED EXPOSURE.
WASH THOROUGHLY AFTER HANDLING.
WASH CONTAMINATED CLOTHING BEFORE REUSE.
IRRITANT.
KEEP TIGHTLY CLOSED.
STORE IN A COOL DRY PLACE.

SECTION 9. PHYSICAL AND CHEMICAL PROPERTIES
APPEARANCE AND ODOR
ORANGE POWDER
PHYSICAL PROPERTIES
SPECIFIC GRAVITY: 4.820

SECTION 10. STABILITY AND REACTIVITY
INCOMPATIBILITIES
STRONG OXIDIZING AGENTS

SECTION 11. TOXICOLOGICAL INFORMATION
ACUTE EFFECTS
DAMAGE TO THE LUNGS
DAMAGE TO THE LIVER
DAMAGE TO THE KIDNEYS
EXPOSURE CAN CAUSE:
HARMFUL IF INHALED OR SWALLOWED.
CAUSES IRRITATION.
CHRONIC EFFECTS
CARCINOGEN.
TARGET ORGAN(S):
DAMAGE TO THE LUNGS
DAMAGE TO THE LIVER
DAMAGE TO THE KIDNEYS
LUNGS

RTECS #: EV3150000
Cadmium Sulfide

TOXICITY DATA
ORL-RAT LD50:7080 MG/KG 41HTAH -14,1978
ORL-MUS LD90:1166 MG/KG 41HTAH -14,1978

TARGET ORGAN DATA
BLOOD (LYMPHOMA INCLUDING HODGKIN'S DISEASE)
TUMORIGENIC (CARCINOGENIC BY RTECS CRITERIA)
TUMORIGENIC 'EQUIVOCAL TUMORIGENIC AGENT BY RTECS CRITERIA)
TUMORIGENIC' (TUMORS AT SITE OF APPLICATION)
ONLY SELECTED REGISTRY OF TOXIC EFFECTS OF CHEMICAL SUBSTANCES
(RTECS) DATA IS PRESENTED HERE. SEE ACTUAL ENTRY IN RTECS FOR
COMPLETE INFORMATION.

SECTION 12. - - - - - - ECOLOGICAL INFORMATION - - - - - -
DATA NOT YET AVAILABLE.

SECTION 13. - - - - - - DISPOSAL CONSIDERATIONS - - - - - -
BURY IN A LANDFILL SITE APPROVED FOR THE DISPOSAL OF CHEMICAL
AND HAZARDOUS WASTES.
OBSERVE ALL FEDERAL, STATE AND LOCAL ENVIRONMENTAL REGULATIONS.

SECTION 14. - - - - - - TRANSPORT INFORMATION - - - - - -
CONTACT ALDRICH CHEMICAL COMPANY FOR TRANSPORTATION INFORMATION.

SECTION 15. - - - - - - REGULATORY INFORMATION - - - - - -
EUROPEAN INFORMATION
EC INDEX NO: 048-010-00-4
TOXIC
R 22
HARMFUL IF SWALLOWED.
R 40
POSSIBLE RISK OF IRREVERSIBLE EFFECTS.
R 48/23/25
TOXIC: DANGER OF SERIOUS DAMAGE TO HEALTH BY PROLONGED EXPOSURE
THROUGH INHALATION AND IF SWALLOWED.
S 22
DO NOT BREATHE DUST.
S 36/37
WEAR SUITABLE PROTECTIVE CLOTHING AND GLOVES.
S 45
IN CASE OF ACCIDENT OR IF YOU FEEL UNWELL, SEEK MEDICAL ADVICE
IMMEDIATELY (SHOW THE LABEL WHERE POSSIBLE).
REVIEWS, STANDARDS, AND REGULATIONS
OEL*MAK
ACGIH TLV-TWA 0.01 MG(CD)/M3, INHALABLE DUST DTLVS* TLV/BEL,1999
ACGIH TLV-TWA 0.002 MG(CD)/M3, RESPIRABLE DUST DTLVS* TLV/BEL,1999
ACGIH TLV-SUSPECTED HUMAN CARCINOGEN DTLVS* TLV/BEL,1999
IARC CANCER REVIEW: ANIMAL SUFFICIENT EVIDENCE IMEMDT 2,74,1973
IARC CANCER REVIEW: ANIMAL SUFFICIENT EVIDENCE IMEMDT 11,39,1976
IARC CANCER REVIEW: ANIMAL SUFFICIENT EVIDENCE IMEMDT 58,119,1993
IARC CANCER REVIEW: HUMAN SUFFICIENT EVIDENCE IMEMDT 58,119,1993
IARC CANCER REVIEW: GROUP I IMEMDT 58,119,1993
MSHA STANDARD-AIR: TWA 0.2 MG(CD)/M3
DTLVS* 3,34,1971
OEL-ARAB REPUBLIC OF EGYPT: TWA 0.05 MG(CD)/M3, JAN1993
OEL-AUSTRALIA: TWA 0.05 MG(CD)/M3, JAN1993
OEL-AUSTRIA: CARCINOGEN, JAN1999
OEL-BELGIUM: TWA 0.05 MG(CD)/M³, JAN 1993
OEL-DENMARK: TWA 0.01 MG(CD)/M³, JAN 1999
OEL-FINLAND: TWA 0.02 MG(CD)/M³, CARCINOGEN, JAN 1999
OEL-FRANCE: VME 0.05 MG(CD)/M³, JAN 1999
OEL-GERMANY: CARCINOGEN, JAN 1999
OEL-INDIA: TWA 0.05 MG(CD)/M³, JAN 1993
OEL-JAPAN: TWA 0.05 MG(CD)/M³, GROUP I CARCINOGEN, JAN 1999
OEL-THE NETHERLANDS: MAC-TGG 0.02 MG(CD)/M³, MAC-K 0.1 MG(CD)/M³, JAN 1999
OEL-NORWAY: TWA 0.05 MG(CD)/M³, JAN 1999
OEL-POLAND: MAC(TWA) FUME 0.02 MG(CD)/M³, MAC(STEL) FUME 0.05 MG(CD)/M³, JAN 1999
OEL-POLAND: MAC(TWA) DUST 0.04 MG(CD)/M³, MAC(STEL) DUST 0.2 MG(CD)/M³, JAN 1999
OEL-RUSSIA: TWA 0.01 MG(CD)/M³, STEL 0.05 MG(CD)/M³, JAN 1993
OEL-SWITZERLAND: MAK-W 0.05 MG(CD)/M³, CARCINOGEN, JAN 1999
OEL-THAILAND: TWA 0.2 MG(CD)/M³, STEL 0.5 MG(CD)/M³, JAN 1993
OEL-TURKEY: TWA 0.2 MG(CD)/M³, JAN 1993
OEL-UNITED KINGDOM: TWA 0.03 MG(CD)/M³, SEP 2000
OEL IN ARGENTINA, BULGARIA, COLOMBIA, JORDAN, KOREA CHECK ACGIH TLV;
OEL IN NEW ZEALAND, SINGAPORE, VIETNAM CHECK ACGIH TLV
NIOSH REL TO CADMIUM, DUST AND FUME-AIR: CA LOWEST FEASIBLE CONC.
NIOSH* DHHS #92-100, 1992
NOHS 1974: HZD 83628; NIS 39; TNE 19293
NOFS 1983: HZD 83628; NIS 32; TNE 1625; NOS 38; TNE 42562; TFE 16685
EPA GENETOX PROGRAM 1988, POSITIVE: CARCINOGENICITY-MOUSE/RAT
EPA GENETOX PROGRAM 1988, POSITIVE: IN VITRO CYTOGENETICS-HUMAN
LYMPHOCYTE
EPA TSCA SECTION 8(B) CHEMICAL INVENTORY
EPA TSCA SECTION 8(D) UNPUBLISHED HEALTH/SAFETY STUDIES
EPA TSCA TEST SUBMISSION (TSCATS) DATABASE, JANUARY 2001
NTP 9TH REPORT ON CARCINOGENS, 2000: KNOWN TO BE HUMAN CARCINOGEN
U.S. INFORMATION
THIS PRODUCT IS SUBJECT TO SARA SECTION 313 REPORTING REQUIREMENTS.
CALIFORNIA PROPOSITION 65:
THIS PRODUCT IS OR CONTAINS CHEMICAL(S) KNOWN TO THE STATE OF CALIFORNIA TO CAUSE CANCER.
THIS PRODUCT IS SUBJECT TO SARA SECTION 313 REPORTING REQUIREMENTS.
SECTION 16. OTHER INFORMATION-
THE ABOVE INFORMATION IS BELIEVED TO BE CORRECT BUT DOES NOT PURPORT TO BE ALL INCLUSIVE AND SHALL BE USED ONLY AS A GUIDE. SIGMA, ALDRICH, FLUKA SHALL NOT BE HELD LIABLE FOR ANY DAMAGE RESULTING FROM HANDLING OR FROM CONTACT WITH THE ABOVE PRODUCT. SEE REVERSE SIDE OF INVOICE OR PACKING SLIP FOR ADDITIONAL TERMS AND CONDITIONS OF SALE.
COPYRIGHT 2001 SIGMA-ALDRICH CO.
LICENSE GRANTED TO MAKE UNLIMITED PAPER COPIES FOR INTERNAL USE ONLY.
APPENDIX B: SIMS ASCII File

IMS
CAMECA

DEPTHEROFILE: 0711010
1.dp

DEFTANAL:DEF.ANALYSIS

Date: 07.11.01 Time: 10:17
User name: PRINCE
Sample name: 08C
Sample stage position: X = 8044 urn Y = -6998 urn
Total acq. time: 2992 s
Beam blanking: N
Ref. signal: N
Auto HV cal.: N
Auto mass cal.: N
Pre sputtering: N

MC: MEASUREMENT CONDITIONS

<table>
<thead>
<tr>
<th>Isotope</th>
<th>Mass (amu)</th>
<th>Abundance (wt%)</th>
<th>Cl time (s)</th>
<th>Offset (s)</th>
<th>Voltage (V)</th>
</tr>
</thead>
<tbody>
<tr>
<td>133Cs</td>
<td>132.905 FC</td>
<td>1.054</td>
<td>1 s</td>
<td>offset</td>
<td>0 V</td>
</tr>
<tr>
<td>133Cs 16O</td>
<td>148.9 EM</td>
<td>0.252</td>
<td>1 s</td>
<td>offset</td>
<td>0 V</td>
</tr>
<tr>
<td>133Cs 28Si</td>
<td>160.882 EM</td>
<td>0.209</td>
<td>1 s</td>
<td>offset</td>
<td>0 V</td>
</tr>
<tr>
<td>133Cs 32S</td>
<td>164.877 EM</td>
<td>0.136</td>
<td>1 s</td>
<td>offset</td>
<td>0 V</td>
</tr>
<tr>
<td>133Cs 75As</td>
<td>207.827 EM</td>
<td>0.457</td>
<td>1 s</td>
<td>offset</td>
<td>0 V</td>
</tr>
<tr>
<td>133Cs 114Cd</td>
<td>246.809 EM</td>
<td>0.394</td>
<td>1 s</td>
<td>offset</td>
<td>0 V</td>
</tr>
<tr>
<td>133Cs 115In</td>
<td>247.809 EM</td>
<td>0.107</td>
<td>1 s</td>
<td>offset</td>
<td>0 V</td>
</tr>
</tbody>
</table>

AP: ANALYTICAL PARAMETERS

1- PRIMARY

Ion: Cs+
HV: 1.06 kV
Arc current: 1.34 mA
Primary current (Init.): 1.97 nA
Primary current (Final): 2.01 nA
Raster Size: 250 um
Primary Beam diameter: 15 um
MR Aperture: 2000
L4 Aperture: 750
Duo pressure:

2- SECONDARY

HV Sample: 8.61 kV
Trans Lens: 250 um
<table>
<thead>
<tr>
<th>Parameter</th>
<th>Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>ESA inner</td>
<td>-557.6 V</td>
</tr>
<tr>
<td>ESA outer</td>
<td>502.8 V</td>
</tr>
<tr>
<td>Slit entrance width</td>
<td>0 (au)</td>
</tr>
<tr>
<td>Slit exit width</td>
<td>0 (au)</td>
</tr>
<tr>
<td>Energy slit width</td>
<td>120</td>
</tr>
<tr>
<td>DTOS X</td>
<td>100 %</td>
</tr>
<tr>
<td>DTOS Y</td>
<td>0 %</td>
</tr>
<tr>
<td>Sll X</td>
<td>0 %</td>
</tr>
<tr>
<td>Sll Y</td>
<td>0 %</td>
</tr>
<tr>
<td>Mass reso</td>
<td>300</td>
</tr>
<tr>
<td>Contrast Aperture</td>
<td>400</td>
</tr>
<tr>
<td>Field Aperture</td>
<td>400</td>
</tr>
<tr>
<td>Analysis chamber pressure:</td>
<td></td>
</tr>
</tbody>
</table>

3- DETECTOR PARAMETERS

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>EM Yield</td>
<td>95 %</td>
</tr>
<tr>
<td>EM Dead Time</td>
<td>25 ns</td>
</tr>
<tr>
<td>EM Background</td>
<td>1.06E+01 c/s</td>
</tr>
<tr>
<td>FC Background</td>
<td>300000 c/s</td>
</tr>
<tr>
<td>EM-&gt;FC Threshold</td>
<td>600000 c/s</td>
</tr>
<tr>
<td>FC-&gt;EM Threshold</td>
<td>1100000 c/s</td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>Element</th>
<th>[s]</th>
<th>[c/s]</th>
<th>[s]</th>
<th>[c/s]</th>
<th>[s]</th>
<th>[c/s]</th>
<th>[s]</th>
<th>[c/s]</th>
</tr>
</thead>
<tbody>
<tr>
<td>133Cs</td>
<td>2.0E+00</td>
<td>2.20E+06</td>
<td>3.34E+00</td>
<td>2.15E+04</td>
<td>7.17E+00</td>
<td>2.80E+02</td>
<td>9.70E+00</td>
<td>1.11E+02</td>
</tr>
<tr>
<td>133Cs</td>
<td>1.96E+00</td>
<td>2.33E+07</td>
<td>1.30E+01</td>
<td>3.46E+04</td>
<td>1.69E+01</td>
<td>1.50E+02</td>
<td>1.94E+01</td>
<td>6.77E+01</td>
</tr>
<tr>
<td>133Cs</td>
<td>2.15E+00</td>
<td>3.76E+07</td>
<td>2.27E+01</td>
<td>3.36E+04</td>
<td>2.66E+01</td>
<td>1.13E+02</td>
<td>2.91E+01</td>
<td>8.26E+01</td>
</tr>
<tr>
<td>133Cs</td>
<td>3.12E+00</td>
<td>4.77E+07</td>
<td>3.24E+01</td>
<td>3.32E+04</td>
<td>3.63E+01</td>
<td>9.21E+01</td>
<td>3.88E+01</td>
<td>6.77E+01</td>
</tr>
<tr>
<td>133Cs</td>
<td>4.09E+00</td>
<td>5.50E+07</td>
<td>4.22E+01</td>
<td>3.16E+04</td>
<td>4.60E+01</td>
<td>6.36E+01</td>
<td>4.85E+01</td>
<td>7.62E+01</td>
</tr>
<tr>
<td>133Cs</td>
<td>5.06E+00</td>
<td>5.97E+07</td>
<td>5.19E+01</td>
<td>3.13E+04</td>
<td>5.57E+01</td>
<td>6.56E+01</td>
<td>5.82E+01</td>
<td>7.41E+01</td>
</tr>
<tr>
<td>133Cs</td>
<td>6.03E+00</td>
<td>6.25E+07</td>
<td>6.16E+01</td>
<td>3.05E+04</td>
<td>6.54E+01</td>
<td>5.40E+01</td>
<td>6.79E+01</td>
<td>7.41E+01</td>
</tr>
<tr>
<td>133Cs</td>
<td>7.00E+00</td>
<td>8.48E+07</td>
<td>7.13E+01</td>
<td>3.00E+04</td>
<td>7.51E+01</td>
<td>4.23E+01</td>
<td>7.76E+01</td>
<td>6.56E+01</td>
</tr>
<tr>
<td>133Cs</td>
<td>7.97E+00</td>
<td>6.80E+07</td>
<td>8.10E+01</td>
<td>2.94E+04</td>
<td>8.48E+01</td>
<td>3.59E+01</td>
<td>8.73E+01</td>
<td>5.08E+01</td>
</tr>
<tr>
<td>133Cs</td>
<td>8.94E+00</td>
<td>6.71E+07</td>
<td>9.07E+01</td>
<td>2.89E+04</td>
<td>9.45E+01</td>
<td>4.23E+01</td>
<td>9.70E+01</td>
<td>6.35E+01</td>
</tr>
<tr>
<td>133Cs</td>
<td>9.91E+00</td>
<td>6.77E+07</td>
<td>1.00E+02</td>
<td>2.66E+04</td>
<td>1.04E+02</td>
<td>4.23E+01</td>
<td>1.07E+02</td>
<td>6.86E+01</td>
</tr>
<tr>
<td>133Cs</td>
<td>1.09E+01</td>
<td>6.85E+07</td>
<td>1.10E+02</td>
<td>2.78E+04</td>
<td>1.14E+02</td>
<td>3.81E+01</td>
<td>1.16E+02</td>
<td>8.36E+01</td>
</tr>
<tr>
<td>133Cs</td>
<td>1.19E+01</td>
<td>6.91E+07</td>
<td>1.20E+02</td>
<td>2.76E+04</td>
<td>1.24E+02</td>
<td>5.50E+01</td>
<td>1.26E+02</td>
<td>7.73E+01</td>
</tr>
<tr>
<td>133Cs</td>
<td>1.28E+01</td>
<td>6.87E+07</td>
<td>1.29E+02</td>
<td>2.72E+04</td>
<td>1.33E+02</td>
<td>4.87E+01</td>
<td>1.36E+02</td>
<td>7.41E+01</td>
</tr>
<tr>
<td>133Cs</td>
<td>1.38E+01</td>
<td>7.01E+07</td>
<td>1.39E+02</td>
<td>2.64E+04</td>
<td>1.43E+02</td>
<td>4.97E+01</td>
<td>1.46E+02</td>
<td>7.20E+01</td>
</tr>
<tr>
<td>133Cs</td>
<td>1.48E+01</td>
<td>7.04E+07</td>
<td>1.49E+02</td>
<td>2.63E+04</td>
<td>1.53E+02</td>
<td>4.12E+01</td>
<td>1.55E+02</td>
<td>7.09E+01</td>
</tr>
<tr>
<td>133Cs</td>
<td>1.57E+01</td>
<td>7.07E+07</td>
<td>1.59E+02</td>
<td>2.55E+04</td>
<td>1.62E+02</td>
<td>4.12E+01</td>
<td>1.65E+02</td>
<td>7.62E+01</td>
</tr>
<tr>
<td>133Cs</td>
<td>1.67E+01</td>
<td>7.10E+07</td>
<td>1.69E+02</td>
<td>2.53E+04</td>
<td>1.72E+02</td>
<td>4.76E+01</td>
<td>1.75E+02</td>
<td>8.79E+01</td>
</tr>
<tr>
<td>133Cs</td>
<td>1.77E+01</td>
<td>7.13E+07</td>
<td>1.78E+02</td>
<td>2.47E+04</td>
<td>1.82E+02</td>
<td>4.44E+01</td>
<td>1.84E+02</td>
<td>8.10E+01</td>
</tr>
<tr>
<td>133Cs</td>
<td>1.87E+01</td>
<td>7.15E+07</td>
<td>1.88E+02</td>
<td>2.47E+04</td>
<td>1.92E+02</td>
<td>4.87E+01</td>
<td>1.94E+02</td>
<td>8.69E+01</td>
</tr>
<tr>
<td>133Cs</td>
<td>1.97E+01</td>
<td>7.16E+07</td>
<td>1.97E+02</td>
<td>2.42E+04</td>
<td>2.01E+02</td>
<td>5.61E+01</td>
<td>2.04E+02</td>
<td>8.04E+01</td>
</tr>
<tr>
<td>133Cs</td>
<td>2.07E+01</td>
<td>7.19E+07</td>
<td>2.07E+02</td>
<td>2.36E+04</td>
<td>2.11E+02</td>
<td>4.02E+01</td>
<td>2.14E+02</td>
<td>9.63E+01</td>
</tr>
<tr>
<td>133Cs</td>
<td>2.16E+01</td>
<td>7.22E+07</td>
<td>2.17E+02</td>
<td>2.35E+04</td>
<td>2.21E+02</td>
<td>4.76E+01</td>
<td>2.23E+02</td>
<td>1.14E+02</td>
</tr>
<tr>
<td>133Cs</td>
<td>2.25E+01</td>
<td>7.20E+07</td>
<td>2.27E+02</td>
<td>2.30E+04</td>
<td>2.30E+02</td>
<td>4.12E+01</td>
<td>2.33E+02</td>
<td>1.31E+02</td>
</tr>
<tr>
<td>133Cs</td>
<td>2.35E+01</td>
<td>7.20E+07</td>
<td>2.36E+02</td>
<td>2.27E+04</td>
<td>2.40E+02</td>
<td>4.76E+01</td>
<td>2.43E+02</td>
<td>1.16E+02</td>
</tr>
<tr>
<td>133Cs</td>
<td>2.45E+01</td>
<td>7.21E+07</td>
<td>2.46E+02</td>
<td>2.21E+04</td>
<td>2.50E+02</td>
<td>4.44E+01</td>
<td>2.52E+02</td>
<td>1.32E+02</td>
</tr>
<tr>
<td>133Cs</td>
<td>2.54E+01</td>
<td>7.22E+07</td>
<td>2.55E+02</td>
<td>2.22E+04</td>
<td>2.59E+02</td>
<td>4.02E+01</td>
<td>2.62E+02</td>
<td>1.42E+02</td>
</tr>
<tr>
<td>133Cs</td>
<td>2.64E+01</td>
<td>7.21E+07</td>
<td>2.65E+02</td>
<td>2.19E+04</td>
<td>2.69E+02</td>
<td>4.76E+01</td>
<td>2.72E+02</td>
<td>1.44E+02</td>
</tr>
<tr>
<td>133Cs</td>
<td>2.74E+01</td>
<td>7.22E+07</td>
<td>2.75E+02</td>
<td>2.15E+04</td>
<td>2.79E+02</td>
<td>4.97E+01</td>
<td>2.81E+02</td>
<td>1.56E+02</td>
</tr>
<tr>
<td>ELEMENT 133Cs 28Si</td>
<td>ELEMENT 133Cs 32S</td>
<td>ELEMENT 133Cs 114Cd</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>-------------------</td>
<td>-------------------</td>
<td>-------------------</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>ELEMENT 133Cs 28Si</td>
<td>ELEMENT 133Cs 32S</td>
<td>ELEMENT 133Cs 114Cd</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>59 points</td>
<td>59 points</td>
<td>59 points</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>[s]</td>
<td>[c/s]</td>
<td>[s]</td>
<td>[c/s]</td>
<td>[s]</td>
<td>[c/s]</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>4.56E+00</td>
<td>6.62E+02</td>
<td>8.44E-04</td>
<td>8.58E+00</td>
<td>3.13E+01</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>1.43E+01</td>
<td>6.15E+02</td>
<td>1.54E+01</td>
<td>6.70E+04</td>
<td>1.83E+01</td>
<td>5.97E+04</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>2.40E+01</td>
<td>3.45E+02</td>
<td>2.51E+01</td>
<td>7.04E+04</td>
<td>2.80E+01</td>
<td>7.32E+04</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>3.37E+01</td>
<td>2.89E+02</td>
<td>3.48E+01</td>
<td>6.96E+04</td>
<td>3.77E+01</td>
<td>7.98E+04</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>4.34E+01</td>
<td>2.73E+02</td>
<td>4.45E+01</td>
<td>6.83E+04</td>
<td>4.74E+01</td>
<td>8.36E+04</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>5.31E+01</td>
<td>2.82E+02</td>
<td>5.42E+01</td>
<td>6.57E+04</td>
<td>5.71E+01</td>
<td>8.54E+04</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>6.28E+01</td>
<td>3.09E+02</td>
<td>6.39E+01</td>
<td>6.49E+04</td>
<td>6.68E+01</td>
<td>8.61E+04</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>7.25E+01</td>
<td>3.24E+02</td>
<td>7.36E+01</td>
<td>6.41E+04</td>
<td>7.65E+01</td>
<td>8.65E+04</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>8.22E+01</td>
<td>3.01E+02</td>
<td>8.33E+01</td>
<td>6.38E+04</td>
<td>8.62E+01</td>
<td>8.73E+04</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>9.19E+01</td>
<td>3.46E+02</td>
<td>9.30E+01</td>
<td>6.26E+04</td>
<td>9.59E+01</td>
<td>8.75E+04</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>1.02E+02</td>
<td>3.67E+02</td>
<td>1.03E+02</td>
<td>6.16E+04</td>
<td>1.06E+02</td>
<td>8.80E+04</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>1.11E+02</td>
<td>3.45E+02</td>
<td>1.12E+02</td>
<td>6.15E+04</td>
<td>1.15E+02</td>
<td>8.88E+04</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>1.21E+02</td>
<td>3.56E+02</td>
<td>1.22E+02</td>
<td>6.04E+04</td>
<td>1.25E+02</td>
<td>8.86E+04</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>1.31E+02</td>
<td>3.83E+02</td>
<td>1.32E+02</td>
<td>6.06E+04</td>
<td>1.35E+02</td>
<td>8.92E+04</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>1.40E+02</td>
<td>4.03E+02</td>
<td>1.42E+02</td>
<td>6.05E+04</td>
<td>1.44E+02</td>
<td>8.93E+04</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>1.50E+02</td>
<td>3.87E+02</td>
<td>1.51E+02</td>
<td>5.99E+04</td>
<td>1.54E+02</td>
<td>9.02E+04</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>1.60E+02</td>
<td>4.03E+02</td>
<td>1.61E+02</td>
<td>5.96E+04</td>
<td>1.64E+02</td>
<td>8.98E+04</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>1.70E+02</td>
<td>3.92E+02</td>
<td>1.71E+02</td>
<td>5.98E+04</td>
<td>1.74E+02</td>
<td>9.02E+04</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>1.80E+02</td>
<td>4.06E+02</td>
<td>1.80E+02</td>
<td>5.91E+04</td>
<td>1.83E+02</td>
<td>9.06E+04</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>1.90E+02</td>
<td>4.16E+02</td>
<td>1.90E+02</td>
<td>5.92E+04</td>
<td>1.93E+02</td>
<td>9.08E+04</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>2.00E+02</td>
<td>4.51E+02</td>
<td>2.09E+02</td>
<td>5.83E+04</td>
<td>2.12E+02</td>
<td>9.05E+04</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>2.18E+02</td>
<td>4.93E+02</td>
<td>2.19E+02</td>
<td>5.84E+04</td>
<td>2.22E+02</td>
<td>9.04E+04</td>
<td></td>
</tr>
<tr>
<td>---</td>
<td>---</td>
<td>---------</td>
<td>---------</td>
<td>---------</td>
<td>---------</td>
<td>---------</td>
<td>---------</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>2.28E+02</td>
<td>5.57E+02</td>
<td>2.29E+02</td>
<td>5.79E+04</td>
<td>2.32E+02</td>
<td>9.03E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>2.37E+02</td>
<td>5.16E+02</td>
<td>2.38E+02</td>
<td>5.78E+04</td>
<td>2.41E+02</td>
<td>9.05E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>2.47E+02</td>
<td>5.59E+02</td>
<td>2.48E+02</td>
<td>5.82E+04</td>
<td>2.51E+02</td>
<td>9.09E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>2.57E+02</td>
<td>5.88E+02</td>
<td>2.58E+02</td>
<td>5.77E+04</td>
<td>2.61E+02</td>
<td>9.08E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>2.67E+02</td>
<td>6.09E+02</td>
<td>2.68E+02</td>
<td>5.79E+04</td>
<td>2.71E+02</td>
<td>8.98E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>2.76E+02</td>
<td>5.76E+02</td>
<td>2.77E+02</td>
<td>5.73E+04</td>
<td>2.80E+02</td>
<td>9.01E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>2.86E+02</td>
<td>6.41E+02</td>
<td>2.87E+02</td>
<td>5.76E+04</td>
<td>2.90E+02</td>
<td>9.07E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>2.96E+02</td>
<td>6.16E+02</td>
<td>2.97E+02</td>
<td>5.73E+04</td>
<td>3.00E+02</td>
<td>9.01E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>3.05E+02</td>
<td>6.84E+02</td>
<td>3.07E+02</td>
<td>5.74E+04</td>
<td>3.09E+02</td>
<td>8.97E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>3.15E+02</td>
<td>6.61E+02</td>
<td>3.16E+02</td>
<td>5.75E+04</td>
<td>3.19E+02</td>
<td>8.93E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>3.25E+02</td>
<td>6.91E+02</td>
<td>3.26E+02</td>
<td>5.71E+04</td>
<td>3.29E+02</td>
<td>8.87E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>3.35E+02</td>
<td>6.30E+02</td>
<td>3.36E+02</td>
<td>5.70E+04</td>
<td>3.39E+02</td>
<td>8.92E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>3.44E+02</td>
<td>6.80E+02</td>
<td>3.45E+02</td>
<td>5.72E+04</td>
<td>3.48E+02</td>
<td>8.84E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>3.54E+02</td>
<td>7.49E+02</td>
<td>3.55E+02</td>
<td>5.64E+04</td>
<td>3.58E+02</td>
<td>8.78E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>3.64E+02</td>
<td>7.64E+02</td>
<td>3.65E+02</td>
<td>5.66E+04</td>
<td>3.68E+02</td>
<td>8.73E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>3.73E+02</td>
<td>7.70E+02</td>
<td>3.74E+02</td>
<td>5.59E+04</td>
<td>3.77E+02</td>
<td>8.62E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>3.83E+02</td>
<td>8.41E+02</td>
<td>3.84E+02</td>
<td>5.57E+04</td>
<td>3.87E+02</td>
<td>8.58E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>3.93E+02</td>
<td>8.53E+02</td>
<td>3.94E+02</td>
<td>5.55E+04</td>
<td>3.97E+02</td>
<td>8.51E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>4.02E+02</td>
<td>9.46E+02</td>
<td>4.04E+02</td>
<td>5.53E+04</td>
<td>4.06E+02</td>
<td>8.47E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>4.12E+02</td>
<td>8.36E+02</td>
<td>4.13E+02</td>
<td>5.45E+04</td>
<td>4.16E+02</td>
<td>8.35E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>4.22E+02</td>
<td>9.46E+02</td>
<td>4.23E+02</td>
<td>5.42E+04</td>
<td>4.26E+02</td>
<td>8.38E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>4.32E+02</td>
<td>9.60E+02</td>
<td>4.33E+02</td>
<td>5.30E+04</td>
<td>4.36E+02</td>
<td>8.34E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>4.41E+02</td>
<td>9.61E+02</td>
<td>4.42E+02</td>
<td>5.25E+04</td>
<td>4.45E+02</td>
<td>7.57E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>4.51E+02</td>
<td>1.00E+03</td>
<td>4.52E+02</td>
<td>5.14E+04</td>
<td>4.55E+02</td>
<td>7.82E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>4.61E+02</td>
<td>1.08E+03</td>
<td>4.62E+02</td>
<td>5.01E+04</td>
<td>4.65E+02</td>
<td>7.68E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>4.70E+02</td>
<td>1.07E+03</td>
<td>4.72E+02</td>
<td>4.94E+04</td>
<td>4.74E+02</td>
<td>7.42E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>4.80E+02</td>
<td>1.10E+03</td>
<td>4.81E+02</td>
<td>4.79E+04</td>
<td>4.84E+02</td>
<td>7.20E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>4.90E+02</td>
<td>1.13E+03</td>
<td>4.91E+02</td>
<td>4.62E+04</td>
<td>4.94E+02</td>
<td>8.37E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>4.99E+02</td>
<td>1.18E+03</td>
<td>5.01E+02</td>
<td>4.46E+04</td>
<td>5.04E+02</td>
<td>8.74E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>5.09E+02</td>
<td>1.16E+03</td>
<td>5.10E+02</td>
<td>4.26E+04</td>
<td>5.13E+02</td>
<td>6.46E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>5.19E+02</td>
<td>1.34E+03</td>
<td>5.20E+02</td>
<td>4.07E+04</td>
<td>5.23E+02</td>
<td>6.16E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>5.29E+02</td>
<td>1.26E+03</td>
<td>5.30E+02</td>
<td>3.87E+04</td>
<td>5.33E+02</td>
<td>5.78E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>5.38E+02</td>
<td>1.27E+03</td>
<td>5.39E+02</td>
<td>3.53E+04</td>
<td>5.42E+02</td>
<td>5.25E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>5.48E+02</td>
<td>1.13E+03</td>
<td>5.49E+02</td>
<td>2.86E+04</td>
<td>5.52E+02</td>
<td>4.12E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>5.58E+02</td>
<td>7.01E+02</td>
<td>5.59E+02</td>
<td>1.51E+04</td>
<td>5.62E+02</td>
<td>1.50E+04</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>5.67E+02</td>
<td>3.59E+02</td>
<td>5.69E+02</td>
<td>5.68E+02</td>
<td>5.71E+02</td>
<td>2.92E+02</td>
<td></td>
</tr>
</tbody>
</table>
APPENDIX C: ANSTO SIMS SAMPLE PREPARATION

Sample Requirements for the ANSTO Cameca ims 5f SIMS.

Introduction
The Cameca ims5F Secondary Ion Mass Spectrometer (SIMS) is a high-precision instrument that operates under an Ultra-High Vacuum (UHV) environment. To preserve this environment, certain precautions need to be taken in the preparation of samples to analyse in the machine. This document outlines the requirements for preparing suitable samples for SIMS analysis in the Cameca ims5f at ANSTO.

There is a fair amount of information and several requirements here, but they can effectively be summarised as:

The sample must be flat, hard, dry, clean, smaller than 25mm in diameter and less than 10mm thick.

Sample Handling
Samples must not be handled directly. Clean gloves or tools such as clean tweezers should be used to handle samples at all times to prevent sample contamination, which leads to vacuum problems (outgassing, see below) and high background signals. Fingerprints outgas and are not SIMS-compatible! They must be removed with a suitable solvent such as ethanol or deionised water before analysis.

Samples must not be contaminated with material such as oil or grease. If a sample is contaminated, it should be washed with a suitable solvent such as ethanol and/or deionised water, preferably in an ultrasonic bath.

Sample Dimensions
Minimum:
- length x width: 3x1 mm
- Thickness: 1 mm, dependent on sample strength

Note a 3x1 mm sample is not desirable. Sample fragility is important as the sample may be subjected to various stresses when fixed in a SIMS sample holder. Small samples can be analysed if they are mounted, for example in resin or on a larger material (See below).

Maximum:
- Circular Sample: 2.5 cm diameter
- Square Sample: 1.79 cm x 1.79 cm
- Thickness: 1 cm

Sample Holder Schematics
A set of sample holder schematics is below showing the available sample holder faceplates. Also included are actual photos of the 18-hole sample holder.

Figure 1: Schematics of available holder faceplates.
Vacuum Requirements
A sample and mounting material able to withstand ultra-high vacuum is required i.e. solid, non-volatile and non-porous.

Preferred Sample Properties
Properties that assist with sample analysis and reliability of results are:
- A flat, polished analysis surface.
- Electrically conductive sample material.
- Homogeneous material. If the sample is heterogeneous, a map or photo of the surface to locate the analysis sites is very useful.
- Symmetrical samples.
- A flat back, alternatively a cylindrical shape not less than 1.5cm in diameter (for fixing in the SIMS sample holder).

Sample Acceptability

Acceptable samples
Samples which are not necessarily of the ideal dimensions or qualities but which possess a flat analysis surface may still be acceptable without requiring sample mounting. All samples must fit into one of the sample holders that are shown in Figure 1 and Figure 2. For example, the following samples could still be accepted as-is.
1. A square metal plate, 1.5cm × 1.5cm × 2mm (L × W × H)
2. Semiconductor wafer material, such as Si or GaAs.
3. Irregularly shaped material less than 1.5cm × 1.5cm × 5mm (L × W × H) that has a smooth, flat analysis surface larger than the minimum specifications above.
4. Cleaved or polished minerals.
5. Materials mounted in resin with the analysis surface exposed.

For samples that do not meet the above specifications, for example powders, soils and biologically based samples, contact the ANSTO SIMS staff for advice and assistance on the preparation and mounting of samples for SIMS analysis.

Undesirable Qualities
If present these sample qualities will prevent a proper analysis being performed.
- Curled edges that protrude from the analysis surface (e.g. a piece of metal cut with tin snips).
• Sample analysis surfaces contaminated and/or buried under resin (see Mounting samples In Resin, below) or other inappropriate foreign material.
• Samples “dirty” with fingerprints, oil, power, cleaning paste, polishing paste, etc.
• Damp, wet or uncured (ie samples only put in resin a couple of hours ago/the night before) samples.
• Samples marked with ink pens (unless the ink is encapsulated, for example in resin).
• Samples compatible with SEMs, electron microprobes, etc. are not necessarily SIMS compatible. Check with a member of the ANSTO SIMS staff beforehand for advice. Common “sticky-tape” is not SIMS-compatible, although special vacuum “sticky-tape” may be.

Sample Outgassing
All samples outgas (sometimes for days) so consult the SIMS staff about this possibility well before scheduled analysis time. Some examples of problem samples for outgassing include cement material, oil shales, shells, resin-mounted material. A vacuum pumping station is available in the SIMS laboratory for the outgassing of samples prior to analysis. If there is any question of outgassing, please contact a SIMS team member to evaluate the necessity of outgassing in the pumping station prior to analysis.

Non-conductive Samples
Samples which are non-conductive lead to analysis problems in the SIMS. Examples include some minerals such as sphalerite, biological material, glass, plastics and resin. Samples which do not conduct electricity have to be either charge-compensated during analysis (problematic) or coated with a conductive layer (eg Gold) prior to analysis. Gold coating of non-conductive samples can be performed in the SIMS laboratory. Charge compensation is possible, but time-consuming and not always reliable. Samples coated with carbon (eg for SEM) are also acceptable, however it should be noted that analysis for carbon, or species with masses which may have carbon-related interferences (C₂, CH₂ etc), will be somewhat difficult due to the overwhelming background.

Mounting samples

On or in another material
Samples that are too small or irregular may be mounted on another piece of material, such as a piece of flat metal, a SEM sample stub with pin removed or other suitable material. If done so, the sample should be fixed with silver paint, which will provide a good electrical contact. If the sample is mounted on a non-conductive material such as glass, then further steps such as gold coating may need to be taken to ensure a good electrical group of the sample is made.

In Resin
Samples that do not readily present their surface for analysis, for example mineral grains and biological material, may require sample mounting in a vacuum-compatible resin. Samples which have analysis surfaces smaller than 3 x 1mm will almost certainly require mounting in a resin to be compatible with the SIMS sample holders. Samples should be mounted with the analysis surface flush with the top of the resin. Refer to Figure 3.

![Figure 3: Example of a sample mounted in cylindrical resin. Side-on view.](image-url)
Types of resin to use
The following resins have been found to perform acceptably for SIMS analysis when mixed properly. There may be others that are also acceptable. Once set, these resins may require a couple of days of outgassing in a vacuum chamber. All resins when ordered as a kit should come with the appropriate hardener and instructions on correct mixing procedures.

<table>
<thead>
<tr>
<th>Resin Name</th>
<th>Company</th>
<th>Contact Address</th>
<th>Extra Info</th>
</tr>
</thead>
<tbody>
<tr>
<td>EPIREZ 133</td>
<td>Epirez Construction Products</td>
<td>2 Seville Street, Villawood NSW 2163 Australia</td>
<td>ph: +61-2-9726-8899</td>
</tr>
<tr>
<td>Daystar Resin LC3600</td>
<td>Daystar</td>
<td>396 Princes Hwy, Rockdale NSW 2216 Australia</td>
<td>ph: +61-2-9567-3328</td>
</tr>
<tr>
<td>Epoxy Resin QC (Quick Cure) Ltd.</td>
<td>Leco Aust. Pty. Ltd.</td>
<td>4/10 Salisbury Rd, Castle Hill NSW 2154 Australia</td>
<td>5:1 (resin:hardener) Small Kit 811-583-130: $88.75</td>
</tr>
<tr>
<td>EPO-THIN</td>
<td>Selby-Biolab</td>
<td>Unit 5/43-51 College St, Gladesville NSW 2111</td>
<td>Thin, suitable for porous samples, filling small voids and holes.</td>
</tr>
</tbody>
</table>

Avoid getting resin onto the analysis face of the sample. Filling pores or holes in the analysis face (especially when using with EPO_THIN) may result in analysis results reflecting the resin rather than your sample.

An “Ideal” sample
The “ideal” vacuum-compatible sample would be a solid cylindrical disc 2.4cm in diameter and 5mm thick, electrically conductive, non-porous/impermeable and homogeneous with flat, polished surfaces. Refer to Figure 4.

![Figure 4: The “ideal” sample.](image)

Sample Identification
Samples should be individually identifiable, preferably with distinctive markings or labels placed on the sample, eg by using a diamond scribe. Do not use a standard ink pen (vacuum compatibility problems). If this is a problem, eg for delicate samples such as thin wafers, and small pieces of irregular-shaped material, they should be encapsulated individually with the identification clearly marked on the capsule.

Sample Submission
Samples may be:
1. Submitted in person.
2. Submitted by courier.
3. Sent by mail in a padded envelope or box.
Samples submitted by mail or courier should arrive at least 5 working days before the scheduled analysis time. This is especially important for samples that need to be placed in the vacuum pumping station for outgassing prior to analysis.

If samples are to be submitted by courier or mail without the researcher being present during analysis, they should be accompanied by the following information:

- Analysis type (e.g., depth profile or imaging)
- Species to be analysed for (if necessary)
- Analysis conditions if known: Consult SIMS staff- primary beam type, current, raster size, max/min depth required.
- Sample name, composition, type, structure, size, placement, position (if not obvious), side or face to be analysed and anything else considered necessary to identify the sample and perform the analysis required. Diagrams are most helpful.

If there are any further questions, or something is not clear, please contact one of the SIMS team members for more details.

Contact Details

SIMS Team: Kathryn Prince +61·2·9717·9217
Natalie Chapman +61·2·9717·9550
Ian Kelly +61·2·9717·3217
Rob Russell +61·2·9717·3891

Mailing Address: Environment Division
ANSTO
Private Mailbag 1
Menai NSW 2234 Australia

Lab Phone +61·2·9717·9218
Email: kathryn.prince@ansio.gov.au
Last update: 10/14/02

110
## APPENDIX D: X-Ray Emission Lines

**K-level and L-level emission lines in KeV**

<table>
<thead>
<tr>
<th>No.</th>
<th>Element</th>
<th>Ka1</th>
<th>Ka2</th>
<th>Kbl</th>
<th>La1</th>
<th>La2</th>
<th>Lbl</th>
</tr>
</thead>
<tbody>
<tr>
<td>3</td>
<td>Li</td>
<td>0.0543</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>4</td>
<td>Be</td>
<td>0.1085</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>5</td>
<td>B</td>
<td>0.1833</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>6</td>
<td>C</td>
<td>0.277</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>7</td>
<td>N</td>
<td>0.3924</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>8</td>
<td>O</td>
<td>0.5249</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>9</td>
<td>F</td>
<td>0.6768</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>10</td>
<td>Ne</td>
<td>0.8486</td>
<td>0.8486</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>11</td>
<td>Na</td>
<td>1.04908</td>
<td>1.04908</td>
<td>1.0711</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>12</td>
<td>Mg</td>
<td>1.25360</td>
<td>1.25360</td>
<td>1.3022</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>13</td>
<td>Al</td>
<td>1.48670</td>
<td>1.48627</td>
<td>1.55745</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>14</td>
<td>Si</td>
<td>1.73998</td>
<td>1.73938</td>
<td>1.83594</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>15</td>
<td>P</td>
<td>2.0137</td>
<td>2.0127</td>
<td>2.1391</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>16</td>
<td>S</td>
<td>2.30784</td>
<td>2.30664</td>
<td>2.46404</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>17</td>
<td>Cl</td>
<td>2.62239</td>
<td>2.62078</td>
<td>2.8156</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>18</td>
<td>Ar</td>
<td>2.95770</td>
<td>2.95563</td>
<td>3.1905</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>19</td>
<td>K</td>
<td>3.3138</td>
<td>3.3111</td>
<td>3.5896</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>20</td>
<td>Ca</td>
<td>3.69168</td>
<td>3.68809</td>
<td>4.0127</td>
<td>0.3413</td>
<td>0.3413</td>
<td>0.3449</td>
</tr>
<tr>
<td>21</td>
<td>Sc</td>
<td>4.0906</td>
<td>4.0861</td>
<td>4.4605</td>
<td>0.3954</td>
<td>0.3954</td>
<td>0.3996</td>
</tr>
<tr>
<td>22</td>
<td>Ti</td>
<td>4.51084</td>
<td>4.50486</td>
<td>4.93181</td>
<td>0.4522</td>
<td>0.4522</td>
<td>0.4584</td>
</tr>
<tr>
<td>23</td>
<td>V</td>
<td>4.95220</td>
<td>4.94646</td>
<td>5.42729</td>
<td>0.5113</td>
<td>0.5113</td>
<td>0.5192</td>
</tr>
<tr>
<td>24</td>
<td>Cr</td>
<td>5.41472</td>
<td>5.405509</td>
<td>5.9671</td>
<td>0.5728</td>
<td>0.5728</td>
<td>0.5828</td>
</tr>
<tr>
<td>25</td>
<td>Mn</td>
<td>5.89875</td>
<td>5.88760</td>
<td>6.49045</td>
<td>0.6374</td>
<td>0.6374</td>
<td>0.6488</td>
</tr>
<tr>
<td>26</td>
<td>Fe</td>
<td>6.40384</td>
<td>6.39094</td>
<td>7.05798</td>
<td>0.7050</td>
<td>0.7050</td>
<td>0.7185</td>
</tr>
<tr>
<td>27</td>
<td>Co</td>
<td>6.93032</td>
<td>6.91539</td>
<td>7.64943</td>
<td>0.7762</td>
<td>0.7762</td>
<td>0.7914</td>
</tr>
<tr>
<td>28</td>
<td>Ni</td>
<td>7.47815</td>
<td>7.46089</td>
<td>8.26466</td>
<td>0.8515</td>
<td>0.8515</td>
<td>0.8888</td>
</tr>
<tr>
<td>29</td>
<td>Cu</td>
<td>8.04778</td>
<td>8.02783</td>
<td>8.90529</td>
<td>0.9297</td>
<td>0.9297</td>
<td>0.9498</td>
</tr>
<tr>
<td>30</td>
<td>Zn</td>
<td>8.63886</td>
<td>8.61578</td>
<td>9.5720</td>
<td>1.0117</td>
<td>1.0117</td>
<td>1.0347</td>
</tr>
<tr>
<td>32</td>
<td>Ge</td>
<td>9.88642</td>
<td>9.85352</td>
<td>10.9821</td>
<td>1.18800</td>
<td>1.18800</td>
<td>1.2185</td>
</tr>
<tr>
<td>33</td>
<td>As</td>
<td>10.54372</td>
<td>10.50799</td>
<td>11.7262</td>
<td>1.2820</td>
<td>1.2820</td>
<td>1.3170</td>
</tr>
<tr>
<td>34</td>
<td>Se</td>
<td>11.2224</td>
<td>11.1914</td>
<td>12.4959</td>
<td>1.37910</td>
<td>1.37910</td>
<td>1.4192</td>
</tr>
<tr>
<td>35</td>
<td>Br</td>
<td>11.9242</td>
<td>11.8776</td>
<td>13.2914</td>
<td>1.4803</td>
<td>1.4803</td>
<td>1.5259</td>
</tr>
<tr>
<td>36</td>
<td>Kr</td>
<td>12.649</td>
<td>12.598</td>
<td>14.112</td>
<td>1.5860</td>
<td>1.5860</td>
<td>1.6366</td>
</tr>
<tr>
<td>37</td>
<td>Rb</td>
<td>13.3953</td>
<td>13.3358</td>
<td>14.9613</td>
<td>1.69413</td>
<td>1.69256</td>
<td>1.7521</td>
</tr>
<tr>
<td>38</td>
<td>Sr</td>
<td>14.1650</td>
<td>14.0979</td>
<td>15.8357</td>
<td>1.8056</td>
<td>1.8056</td>
<td>1.8717</td>
</tr>
<tr>
<td>40</td>
<td>Zr</td>
<td>15.7751</td>
<td>15.6999</td>
<td>17.6678</td>
<td>2.04236</td>
<td>2.0399</td>
<td>2.1244</td>
</tr>
<tr>
<td>41</td>
<td>Nb</td>
<td>16.6151</td>
<td>16.5210</td>
<td>18.6225</td>
<td>2.16589</td>
<td>2.1630</td>
<td>2.2574</td>
</tr>
<tr>
<td>42</td>
<td>Mo</td>
<td>17.47934</td>
<td>17.3743</td>
<td>19.6083</td>
<td>2.29316</td>
<td>2.2895</td>
<td>2.3948</td>
</tr>
<tr>
<td>43</td>
<td>Tc</td>
<td>18.3671</td>
<td>18.2508</td>
<td>20.619</td>
<td>2.4240</td>
<td>2.4240</td>
<td>-</td>
</tr>
<tr>
<td>44</td>
<td>Ru</td>
<td>19.2792</td>
<td>19.1504</td>
<td>21.6568</td>
<td>2.5585</td>
<td>2.5585</td>
<td>2.6832</td>
</tr>
<tr>
<td>45</td>
<td>Rh</td>
<td>20.2161</td>
<td>20.0737</td>
<td>22.7236</td>
<td>2.69674</td>
<td>2.69205</td>
<td>2.8344</td>
</tr>
<tr>
<td>46</td>
<td>Pd</td>
<td>21.1771</td>
<td>21.0201</td>
<td>23.8187</td>
<td>2.83861</td>
<td>2.83235</td>
<td>2.9902</td>
</tr>
<tr>
<td>47</td>
<td>Ag</td>
<td>22.16292</td>
<td>21.9903</td>
<td>24.9424</td>
<td>2.98431</td>
<td>2.97821</td>
<td>3.1509</td>
</tr>
<tr>
<td>49</td>
<td>In</td>
<td>24.2097</td>
<td>24.0020</td>
<td>27.2759</td>
<td>3.26894</td>
<td>3.27929</td>
<td>3.4872</td>
</tr>
<tr>
<td>50</td>
<td>Sn</td>
<td>25.2713</td>
<td>25.0440</td>
<td>28.4860</td>
<td>3.44398</td>
<td>3.43542</td>
<td>3.6628</td>
</tr>
<tr>
<td>52</td>
<td>Te</td>
<td>27.4723</td>
<td>27.2017</td>
<td>30.9957</td>
<td>3.76933</td>
<td>3.7588</td>
<td>4.0295</td>
</tr>
<tr>
<td>54</td>
<td>Xe</td>
<td>29.779</td>
<td>29.458</td>
<td>33.624</td>
<td>4.1099</td>
<td>4.1099</td>
<td>-</td>
</tr>
<tr>
<td>55</td>
<td>Cs</td>
<td>30.9728</td>
<td>30.6251</td>
<td>34.9869</td>
<td>4.2865</td>
<td>4.2722</td>
<td>4.6198</td>
</tr>
<tr>
<td>56</td>
<td>Ba</td>
<td>32.1936</td>
<td>31.8171</td>
<td>36.3782</td>
<td>4.46626</td>
<td>4.43090</td>
<td>4.8275</td>
</tr>
<tr>
<td>57</td>
<td>La</td>
<td>33.4418</td>
<td>33.0341</td>
<td>37.8010</td>
<td>4.65097</td>
<td>4.63423</td>
<td>5.0421</td>
</tr>
<tr>
<td>58</td>
<td>Ce</td>
<td>34.7197</td>
<td>34.2789</td>
<td>39.2573</td>
<td>4.8402</td>
<td>4.8230</td>
<td>5.2622</td>
</tr>
<tr>
<td>59</td>
<td>Pr</td>
<td>36.0263</td>
<td>35.5502</td>
<td>40.7482</td>
<td>5.0337</td>
<td>5.0135</td>
<td>5.4889</td>
</tr>
<tr>
<td>60</td>
<td>Nd</td>
<td>37.3101</td>
<td>36.8474</td>
<td>42.2713</td>
<td>5.2304</td>
<td>5.2077</td>
<td>5.7216</td>
</tr>
<tr>
<td>61</td>
<td>Pm</td>
<td>38.7247</td>
<td>38.1712</td>
<td>43.8261</td>
<td>5.4325</td>
<td>5.4078</td>
<td>5.9611</td>
</tr>
<tr>
<td>62</td>
<td>Sm</td>
<td>40.1181</td>
<td>39.5224</td>
<td>45.4130</td>
<td>5.6361</td>
<td>5.6090</td>
<td>6.2051</td>
</tr>
<tr>
<td>63</td>
<td>Eu</td>
<td>41.5422</td>
<td>40.9019</td>
<td>47.0379</td>
<td>5.8457</td>
<td>5.8166</td>
<td>6.4564</td>
</tr>
<tr>
<td>64</td>
<td>Gd</td>
<td>42.9962</td>
<td>42.3089</td>
<td>48.6970</td>
<td>6.0572</td>
<td>6.0250</td>
<td>6.7132</td>
</tr>
<tr>
<td>65</td>
<td>Tb</td>
<td>44.4816</td>
<td>43.7441</td>
<td>50.3820</td>
<td>6.2728</td>
<td>6.2380</td>
<td>6.9780</td>
</tr>
<tr>
<td>66</td>
<td>Dy</td>
<td>45.9984</td>
<td>45.2078</td>
<td>52.1190</td>
<td>6.4952</td>
<td>6.4577</td>
<td>7.2477</td>
</tr>
<tr>
<td>67</td>
<td>Ho</td>
<td>47.5467</td>
<td>46.9979</td>
<td>53.8771</td>
<td>6.7198</td>
<td>6.6795</td>
<td>7.5233</td>
</tr>
<tr>
<td>68</td>
<td>Er</td>
<td>49.1277</td>
<td>48.2211</td>
<td>55.6811</td>
<td>6.9487</td>
<td>6.9050</td>
<td>7.8109</td>
</tr>
<tr>
<td>69</td>
<td>Tm</td>
<td>50.7416</td>
<td>50.1712</td>
<td>57.5821</td>
<td>7.1799</td>
<td>7.1331</td>
<td>8.1011</td>
</tr>
<tr>
<td>70</td>
<td>Yb</td>
<td>52.3889</td>
<td>51.3540</td>
<td>59.3721</td>
<td>7.4156</td>
<td>7.3673</td>
<td>8.4018</td>
</tr>
<tr>
<td>71</td>
<td>Lu</td>
<td>54.0698</td>
<td>52.9650</td>
<td>61.2830</td>
<td>7.6555</td>
<td>7.6049</td>
<td>8.7090</td>
</tr>
<tr>
<td>72</td>
<td>Hf</td>
<td>55.7902</td>
<td>54.6114</td>
<td>63.2340</td>
<td>7.8990</td>
<td>7.8446</td>
<td>9.0227</td>
</tr>
<tr>
<td>73</td>
<td>Ta</td>
<td>57.5320</td>
<td>56.2770</td>
<td>65.2230</td>
<td>8.1461</td>
<td>8.0879</td>
<td>9.3431</td>
</tr>
<tr>
<td>74</td>
<td>W</td>
<td>59.3182</td>
<td>57.9817</td>
<td>67.2443</td>
<td>8.3976</td>
<td>8.3352</td>
<td>9.6723</td>
</tr>
<tr>
<td>75</td>
<td>Re</td>
<td>61.1403</td>
<td>59.7179</td>
<td>69.3100</td>
<td>8.6525</td>
<td>8.5862</td>
<td>10.010</td>
</tr>
<tr>
<td>76</td>
<td>Os</td>
<td>63.0005</td>
<td>61.4867</td>
<td>71.4130</td>
<td>8.9117</td>
<td>8.8410</td>
<td>10.355</td>
</tr>
<tr>
<td>77</td>
<td>Ir</td>
<td>64.8956</td>
<td>63.2867</td>
<td>73.5608</td>
<td>9.1751</td>
<td>9.0995</td>
<td>10.708</td>
</tr>
<tr>
<td>78</td>
<td>Pt</td>
<td>66.8332</td>
<td>65.1120</td>
<td>75.7480</td>
<td>9.4423</td>
<td>9.3618</td>
<td>11.070</td>
</tr>
<tr>
<td>79</td>
<td>Au</td>
<td>68.8537</td>
<td>66.9895</td>
<td>77.9930</td>
<td>9.7131</td>
<td>9.6280</td>
<td>11.442</td>
</tr>
<tr>
<td>80</td>
<td>Hg</td>
<td>70.8190</td>
<td>68.8950</td>
<td>80.2530</td>
<td>9.9888</td>
<td>9.8976</td>
<td>11.822</td>
</tr>
<tr>
<td>81</td>
<td>Tl</td>
<td>72.8175</td>
<td>70.8319</td>
<td>82.5760</td>
<td>10.2685</td>
<td>10.1728</td>
<td>12.233</td>
</tr>
<tr>
<td>82</td>
<td>Pb</td>
<td>74.8694</td>
<td>72.8042</td>
<td>84.9365</td>
<td>10.5515</td>
<td>10.4495</td>
<td>12.613</td>
</tr>
<tr>
<td>83</td>
<td>Bi</td>
<td>77.1079</td>
<td>74.8148</td>
<td>87.3430</td>
<td>10.8388</td>
<td>10.7309</td>
<td>13.023</td>
</tr>
<tr>
<td>84</td>
<td>Po</td>
<td>79.2900</td>
<td>76.8620</td>
<td>89.8000</td>
<td>11.1308</td>
<td>11.0158</td>
<td>13.447</td>
</tr>
<tr>
<td>85</td>
<td>At</td>
<td>81.5200</td>
<td>78.9500</td>
<td>92.3000</td>
<td>11.4260</td>
<td>11.3048</td>
<td>13.876</td>
</tr>
<tr>
<td>86</td>
<td>Rn</td>
<td>83.7800</td>
<td>81.0700</td>
<td>94.8700</td>
<td>11.7270</td>
<td>11.5979</td>
<td>14.316</td>
</tr>
<tr>
<td>87</td>
<td>Fr</td>
<td>86.1000</td>
<td>83.2300</td>
<td>97.4700</td>
<td>12.0313</td>
<td>11.8950</td>
<td>14.770</td>
</tr>
<tr>
<td>88</td>
<td>Ra</td>
<td>88.4700</td>
<td>85.4300</td>
<td>100.1300</td>
<td>12.3397</td>
<td>12.1962</td>
<td>15.235</td>
</tr>
<tr>
<td>89</td>
<td>Ac</td>
<td>90.8804</td>
<td>87.6700</td>
<td>102.8500</td>
<td>12.6520</td>
<td>12.5008</td>
<td>15.713</td>
</tr>
<tr>
<td>90</td>
<td>Th</td>
<td>93.3500</td>
<td>89.9500</td>
<td>105.6090</td>
<td>12.9867</td>
<td>12.8096</td>
<td>16.202</td>
</tr>
<tr>
<td>91</td>
<td>Pa</td>
<td>95.8668</td>
<td>92.2870</td>
<td>108.4270</td>
<td>13.2907</td>
<td>13.1222</td>
<td>16.702</td>
</tr>
<tr>
<td>92</td>
<td>U</td>
<td>98.4399</td>
<td>94.6650</td>
<td>111.3000</td>
<td>13.6147</td>
<td>13.4388</td>
<td>17.220</td>
</tr>
<tr>
<td>93</td>
<td>Np</td>
<td>-</td>
<td>-</td>
<td>-</td>
<td>13.9441</td>
<td>13.7597</td>
<td>17.750</td>
</tr>
<tr>
<td>94</td>
<td>Pu</td>
<td>-</td>
<td>-</td>
<td>-</td>
<td>14.2786</td>
<td>14.0842</td>
<td>18.293</td>
</tr>
<tr>
<td>95</td>
<td>Am</td>
<td>-</td>
<td>-</td>
<td>-</td>
<td>14.6172</td>
<td>14.4119</td>
<td>18.852</td>
</tr>
</tbody>
</table>

Values are from J. A. Bearden, "X-Ray Wavelengths", *Review of Modern Physics*, (January 1967) pp. 86-99, unless otherwise noted.
<table>
<thead>
<tr>
<th>Acronym</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>CBD</td>
<td>Chemical Bath Deposition</td>
</tr>
<tr>
<td>SIMS</td>
<td>Secondary Ion Mass Spectroscopy</td>
</tr>
<tr>
<td>ESEM</td>
<td>Environmental Scanning Electron Microscope</td>
</tr>
<tr>
<td>CCI</td>
<td>Charge Contrast Imaging</td>
</tr>
<tr>
<td>PIXE</td>
<td>Proton Induced X-ray Emission</td>
</tr>
<tr>
<td>AINSE</td>
<td>Australian Institute of Nuclear Science and Engineering</td>
</tr>
<tr>
<td>ANSTO</td>
<td>Australian Nuclear Science and Technology Organisation</td>
</tr>
<tr>
<td>MSDS</td>
<td>Materials Safety Data Sheet</td>
</tr>
<tr>
<td>TFT</td>
<td>Thin Film Transistor</td>
</tr>
<tr>
<td>TCO</td>
<td>Transparent Conducting Oxide</td>
</tr>
<tr>
<td>EDAX</td>
<td>Energy Dispersive Analysis of X-rays</td>
</tr>
<tr>
<td>WACM</td>
<td>Western Australian Centre for Microscopy</td>
</tr>
<tr>
<td>PLA</td>
<td>Pressure Limiting Aperture</td>
</tr>
</tbody>
</table>
REFERENCES


Http://www.chembio.uoguelph.ca/educmat/chm729/afm/firstpag.htm


